# Stacked Chip

128M (x16) Boot Block Flash and 16M (x16) SRAM

(Model No.: LRS1395)

Spec No.: MFM2-J14106

Issue Date: January 18, 2002



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	PRELIMINARY
	SPECIFICATIONS
	64M (x16) Flash Memory +64M (x16) Flash Memory
	Product Type+16M (x16) SRAM
	I D C 1 2 0 5
	LRS1395
	Model No ( LRS1395 )
	This device specification is subject to change without notice.
	*This specifications contains <u>40</u> pages including the cover and appendix. *Refer to LH28F320BF, LH28F640BF Series Appendix (FUM00701).
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# **SHARP**

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#### 1. Description

The LRS1395 is a combination memory organized as 4,194,304 x16 bit flash memory, 4,194,304 x16 bit flash memory and 1,048,576 x16 bit static RAM in one package.

#### Features

- Power supply
   Operating temperature
   2.7V to 3.3V
   -25°C to +85°C
- Not designed or rated as radiation hardened
- 72pin CSP (LCSP072-P-0811) plastic package
- Flash memory has P-type bulk silicon, and SRAM has P-type bulk silicon

#### Flash Memory

- F<sub>1</sub>: 64M (x16) bit Flash Memory, F<sub>2</sub>: 64M (x16) bit Flash Memory
- Access Time •••• 70 ns (Max.)
- Power supply current for each Chip (The current for F-V  $_{CC}$  pin and F-V  $_{PP}$  pin)

Read •••• 26 mA (Max. t<sub>CYCLE</sub> = 200ns, CMOS Input)
Word write •••• 61 mA (Max.)

Block erase •••• 31 mA (Max.)
Reset Power-Down •••• 50 μA (Max. F

Reset Power-Down  $\bullet \bullet \bullet \bullet \bullet \quad 50 \ \mu A \quad (Max. \ F-\overline{RST} = GND \pm 0.2V, \\ I_{OUT} \ (F-RY/\overline{BY}) = 0mA)$ 

1<sub>OUT</sub> (1-K1/B1) - 0IIIA)

Standby  $\bullet \bullet \bullet \bullet \qquad 50 \ \mu A \qquad (Max. \ F-\overline{CE} = F-\overline{RST} = F-V_{CC} \pm 0.2V)$ 

- Optimized Array Blocking Architecture for each Chip

Eight 4K-word Parameter Blocks

One-hundred and twenty-seven 32K-word Main Blocks

F<sub>1</sub>: Bottom Parameter Location, F<sub>2</sub>: Top Parameter Location

- Extended Cycling Capability

100,000 Block Erase Cycles (F-V<sub>PP</sub> = 1.65V to 3.3V) 1,000 Block Erase Cycles and total 80 hours (F-V<sub>PP</sub> = 11.7V to 12.3V)

- Enhanced Automated Suspend Options

Word Write Suspend to Read

Block Erase Suspend to Word Write

Block Erase Suspend to Read

## SRAM

- Access Time •••• 70 ns (Max.)

- Power Supply current

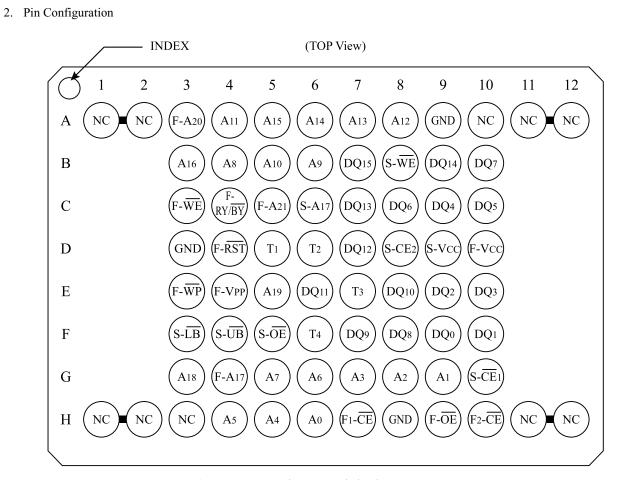
Operating current • • • • • 30 mA (Max.  $t_{RC}$ ,  $t_{WC}$  = Min.)

Standby current •••• 20  $\mu A$  (Max.)

Data retention current  $\bullet \bullet \bullet \bullet \bullet 8 \mu A$  (Max. S-V<sub>CC</sub> = 1.5V)

<sup>\*</sup> In the following pages,  $F_1$ ,  $F_2$  and F are defined as  $F_1$ : 64M (x16) bit Flash,  $F_2$ : 64M (x16) bit Flash, F: both Flashes in common.





Note) From T<sub>1</sub> to T<sub>4</sub> pins are needed to be open. Two NC pins at the corner are connected. Do not float any GND pins.

Pin	Description	Type
A <sub>0</sub> to A <sub>16</sub> , A <sub>18</sub> , A <sub>19</sub>	Address Inputs (Common)	Input
F-A <sub>17</sub> , F-A <sub>20</sub> , F-A <sub>21</sub>	Address Inputs (Flash)	Input
S-A <sub>17</sub>	Address Input (SRAM)	Input
$F_{1,2}$ - $\overline{CE}$	Chip Enable Input (Flash)	Input
$S-\overline{CE}_1$ , $S-CE_2$	Chip Enable Input (SRAM)	Input
F-WE	Write Enable Input (Flash)	Input
S-WE	Write Enable Input (SRAM)	Input
F-OE	Output Enable Input (Flash)	Input
S-OE	Output Enable Input (SRAM)	Input
S- <del>LB</del>	SRAM Byte Enable Input (DQ <sub>0</sub> to DQ <sub>7</sub> )	Input
S-UB	SRAM Byte Enable Input (DQ <sub>8</sub> to DQ <sub>15</sub> )	Input
F-RST		Input
F-WP	Write Protect Input (Flash) When $F-\overline{WP}$ is $V_{IL}$ , locked-down blocks cannot be unlocked. Erase or program operation can be executed to the blocks which are not locked and locked-down. When $F-\overline{WP}$ is $V_{IH}$ , lock-down is disabled.	Input
F-RY/BY	Ready/Busy Output (Flash) During an Erase or Write operation: V <sub>OL</sub> Block Erase and Write Suspend: High-Z (High impedance)	Open Drain Output
DQ <sub>0</sub> to DQ <sub>15</sub>	Data Inputs and Outputs (Common)	Input / Output
F-V <sub>CC</sub>	Power Supply (Flash)	Power
S-V <sub>CC</sub>	Power Supply (SRAM)	Power
F-V <sub>PP</sub>	$\label{eq:Monitoring Power Supply Voltage (Flash)} \\ \text{Block Erase and Write}: F-V_{PP} = V_{PPH1/2} \\ \text{All Blocks Locked}: F-V_{PP} < V_{PPLK} \\ \\$	Input
GND	GND (Common)	Power
NC	Non Connection	-
$T_1$ to $T_4$	Test pins (Should be all open)	-

#### 3. Truth Table

# 3.1 Bus Operation<sup>(1)</sup>

Flash	SRAM	Notes	F- <u>CE</u> <sup>(7)</sup>	F-RST	F-OE	F-WE	$S-\overline{CE}_1$	S-CE <sub>2</sub>	S-OE	S-WE	S- <del>LB</del>	S-UB	DQ <sub>0</sub> to DQ <sub>15</sub>
Read		3,5,8			L			I.				I.	(9)
Output Disable	Standby	5,8	L	Н	Н	Н	(10)		X	X	(1	0)	High - Z
Write		2,3,4,5,8				L							D <sub>IN</sub>
	Read	5,6							L	Н		(1	1)
Standby	Output Disable	5,6	Н	Н	X	X	L	Н	X	Н	Н	Н	High - Z
Standby		3,0							H X	Н	X	X	mgn - Z
	Write	5,6								L	(11)		
	Read	5,6							L	Н		(1	1)
Reset Power	Output	t 5.6	X	L	X	X	T	LH	X	Н	Н	Н	High - Z
Down	Disable	5,6	Λ	L	Λ	Λ	L	п	Н	Н	X	X	nigii - Z
	Write	5,6							X	L		(1	1)
Standby		5	Н	Н									
Reset Power Down	Standby	5,6	X	L X	X	X	(10)		X	X	(10)		High - Z

#### Notes:

- 1.  $L = V_{IL}$ ,  $H = V_{IH}$ , X = H or L, High-Z = High impedance. Refer to the DC Characteristics.
- 2. Command writes involving block erase (page buffer) program are reliably executed when  $F-V_{PP} = V_{PPH1/2}$  and  $F-V_{CC} = 2.7V$  to 3.3V.

Command writes involving full chip erase is reliably executed when  $F-V_{PP}=V_{PPH1}$  and  $F-V_{CC}=2.7V$  to 3.3V. Block erase, full chip erase, (page buffer) program with  $F-V_{PP} < V_{PPH1/2}$  (Min.) produce spurious results and should not be attempted.

- 3. Never hold  $F\overline{OE}$  low and  $F\overline{WE}$  low at the same timing.
- 4. Refer Section 5. Command Definitions for Flash Memory valid D<sub>IN</sub> during a write operation.
- 5.  $F-\overline{WP}$  set to  $V_{IL}$  or  $V_{IH}$ .
- 6. Electricity consumption of Flash Memory is lowest when  $F-\overline{RST} = GND \pm 0.2V$ .
- 7. Never hold  $F_1$ - $\overline{CE}$  low and  $F_2$ - $\overline{CE}$  low at the same timing.
- 8. Read Bus operation or Write Bus operation is not simultaneously operated to F<sub>1</sub> and F<sub>2</sub>.

#### 9. Flash Read Mode

Mode	Address	DQ <sub>0</sub> to DQ <sub>15</sub>	
Read Array	X	$D_{OUT}$	
Read Identifier Codes	See 5.2	See 5.2	
Read Query	Refer to the Appendix	Refer to the Appendix	

# 10. SRAM Standby Mode

10. Sid iiii Standoy Wode								
$S-\overline{CE}_1$	S-CE <sub>2</sub>	S- <del>LB</del>	S-UB					
Н	X	X	X					
X	L	X	X					
X	X	Н	Н					

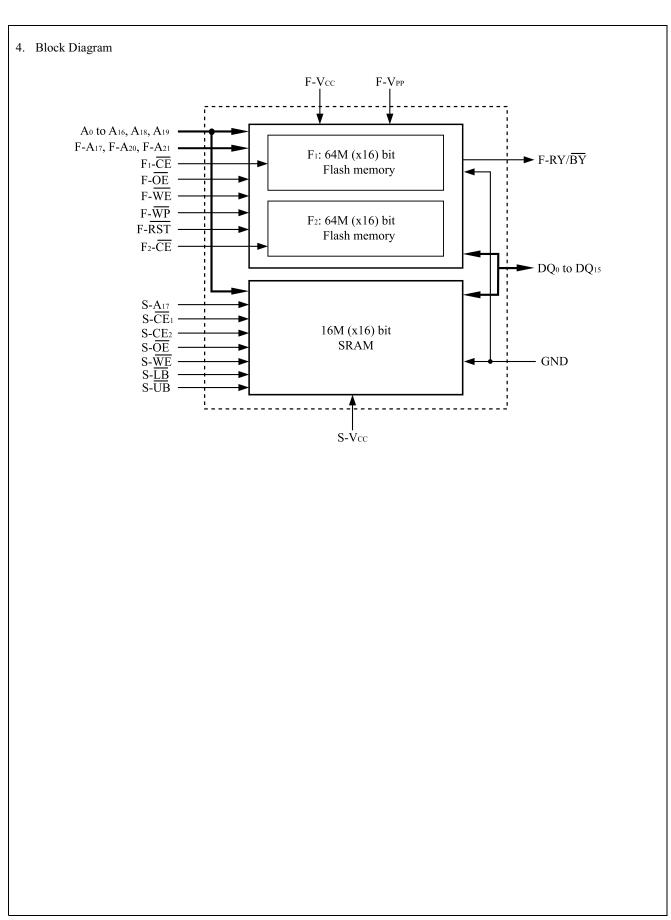
11.S-UB, S-LB Control Mode

S-LB	S-UB	DQ <sub>0</sub> to DQ <sub>7</sub>	DQ <sub>8</sub> to DQ <sub>15</sub>				
L	L	D <sub>OUT</sub> /D <sub>IN</sub>	D <sub>OUT</sub> /D <sub>IN</sub>				
L	Н	D <sub>OUT</sub> /D <sub>IN</sub>	High - Z				
Н	L	High - Z	D <sub>OUT</sub> /D <sub>IN</sub>				

3.2 Simultaneous Operation Modes Allowed with Four Planes $^{(1, 2, 3)}$ 

	THEN THE MODES ALLOWED IN THE OTHER PARTITION IS:										
IF ONE PARTITION IS:	Read Array	Read ID	Read Status	Read Query	Word Program	Page Buffer Program	Block Erase	Full Chip Erase	Program Suspend	Block Erase Suspend	
Read Array	X	X	X	X	X	X	X		X	X	
Read ID	X	X	X	X	X	X	X		X	X	
Read Status	X	X	X	X	X	X	X	X	X	X	
Read Query	X	X	X	X	X	X	X		X	X	
Word Program	X	X	X	X						X	
Page Buffer Program	X	X	X	X						X	
Block Erase	X	X	X	X							
Full Chip Erase			X								
Program Suspend	X	X	X	X						X	
Block Erase Suspend	X	X	X	X	X	X			X		

- 1. "X" denotes the operation available.
- Configurative Partition Dual Work Restrictions:
   Status register reflects partition state, not WSM (Write State Machine) state this allows a status register for each partition.
   Only one partition can be erased or programmed at a time no command queuing.
   Commands must be written to an address within the block targeted by that command.
- 3. This table shows operation which can be performed by only the selected chip, not during 2 chips of  $F_1$  and  $F_2$ .



## 5. Command Definitions for Flash Memory<sup>(11)</sup>

#### 5.1 Command Definitions

	Bus		F	irst Bus Cyc	le	Second Bus Cycle			
Command	Cycles Req'd	Notes	Oper <sup>(1)</sup>	Address <sup>(2)</sup>	Data <sup>(3)</sup>	Oper <sup>(1)</sup>	Address <sup>(2)</sup>	Data <sup>(3)</sup>	
Read Array	1	2	Write	PA	FFH				
Read Identifier Codes	≥ 2	2,3,4	Write	PA	90H	Read	IA	ID	
Read Query	≥ 2	2,3,4	Write	PA	98H	Read	QA	QD	
Read Status Register	2	2,3	Write	PA	70H	Read	PA	SRD	
Clear Status Register	1	2	Write	PA	50H				
Block Erase	2	2,3,5	Write	BA	20H	Write	BA	D0H	
Full Chip Erase	2	2,5,9	Write	X	30H	Write	X	D0H	
Program	2	2,3,5,6	Write	WA	40H or 10H	Write	WA	WD	
Page Buffer Program	≥ 4	2,3,5,7	Write	WA	E8H	Write	WA	N-1	
Block Erase and (Page Buffer) Program Suspend	1	2,8,9	Write	PA	В0Н				
Block Erase and (Page Buffer) Program Resume	1	2,8,9	Write	PA	D0H				
Set Block Lock Bit	2	2	Write	BA	60H	Write	BA	01H	
Clear Block Lock Bit	2	2,10	Write	BA	60H	Write	BA	D0H	
Set Block Lock-down Bit	2	2	Write	BA	60H	Write	BA	2FH	
Set Partition Configuration Register	2	2,3	Write	PCRC	60H	Write	PCRC	04H	

- 1. Bus operations are defined in 3.1 Bus Operation.
- 2. The address which is written at the first bus cycle should be the same as the address which is written at the second bus cycle.
  - X=Any valid address within the device.
  - PA=Address within the selected partition.
  - IA=Identifier codes address (See 5.2 Identifier Codes for Read Operation).
  - OA=Query codes address. Refer to the LH28F320BF, LH28F640BF series Appendix for details.
  - BA=Address within the block being erased, set/cleared block lock bit or set block lock-down bit.
  - WA=Address of memory location for the Program command or the first address for the Page Buffer Program command.
  - PCRC=Partition configuration register code presented on the address A<sub>0</sub>-A<sub>15</sub>.
- 3. ID=Data read from identifier codes (See 5.2 Identifier Codes for Read Operation).
  - QD=Data read from query database. Refer to the LH28F320BF, LH28F640BF series Appendix for details.
  - SRD=Data read from status register. See 6. Status Register Definition for a description of the status register bits.
  - WD=Data to be programmed at location WA. Data is latched on the rising edge of  $F-\overline{WE}$  or  $F-\overline{CE}$  (whichever goes high first).
  - N-1=N is the number of the words to be loaded into a page buffer.
- 4. Following the Read Identifier Codes command, read operations access manufacturer code, device code, block lock configuration code, partition configuration register code (See 5.2 Identifier Codes for Read Operation).
  - The Read Query command is available for reading CFI (Common Flash Interface) information.
- 5. Block erase, full chip erase or (page buffer) program cannot be executed when the selected block is locked. Unlocked block can be erased or programmed when F-RST is V<sub>IH</sub>.
- 6. Either 40H or 10H are recognized by the CUI (Command User Interface) as the program setup.
- 7. Following the third bus cycle, inputs the program sequential address and write data of "N" times. Finally, input the any valid address within the target partition to be programmed and the confirm command (D0H). Refer to the LH28F320BF, LH28F640BF series Appendix for details.



8.	If the program operation in one partition is suspended and the erase operation in other partition is also suspended, the suspended program operation should be resumed first, and then the suspended erase operation should be resumed next.
9.	Full chip erase operation can not be suspended.
10.	Following the Clear Block Lock Bit command, block which is not locked-down is unlocked when $F-\overline{WP}$ is $V_{IL}$ . When $F-\overline{WP}$ is $V_{IH}$ , lock-down bit is disabled and the selected block is unlocked regardless of lock-down configuration.
11.	Commands other than those shown above are reserved by SHARP for future device implementations and should not be used.

# 5.2 Identifier Codes for Read Operation

	Code	Address $[A_{15}-A_0]^{(4)}$	Data [DQ <sub>15</sub> -DQ <sub>0</sub> ]	Notes
Manufacturer Code	Manufacturer Code	0000Н	00B0H	
Device Code	64M Bottom Parameter Device Code (F <sub>1</sub> Selected) 64M Top Parameter Device Code (F <sub>2</sub> Selected)	0001H	00B1H (F <sub>1</sub> Selected) 00B0H (F <sub>2</sub> Selected)	1
	Block is Unlocked		$DQ_0 = 0$	2
Block Lock Configuration	Block is Locked	Block Address	$DQ_0 = 1$	2
Code	Block is not Locked-Down	+ 2	$DQ_1 = 0$	2
	Block is Locked-Down		$DQ_1 = 1$	2
Device Configuration Code	Partition Configuration Register	0006Н	PCRC	3

#### Notes:

- 1. Bottom parameter device has its parameter blocks in the plane 0 (The lowest address). Top parameter device has its parameter blocks in the plane 3 (The highest address).
- 2. DQ<sub>15</sub>-DQ<sub>2</sub> is reserved for future implementation.
- 3. PCRC=Partition Configuration Register Code.
- 4. The address A<sub>21</sub>-A<sub>16</sub> are shown in below table for reading the manufacturer, device, lock configuration, device configuration code.

The address to read the identifier codes is dependent on the partition which is selected when writing the Read Identifier Codes command (90H).

See Chapter 6. Partition Configuration Register Definition (P.15) for the partition configuration register.

## Identifier Codes for Read Operation on Partition Configuration (64M-bit device)

Partit	tion Configuration Re	gister	Address (64M-bit device)
PCR.10	PCR.9	PCR.8	$[A_{21}-A_{16}]$
0	0	0	00H
0	0	1	00H or 10H
0	1	0	00H or 20H
1	0	0	00H or 30H
0	1	1	00H or 10H or 20H
1	1	0	00H or 20H or 30H
1	0	1	00H or 10H or 30H
1	1	1	00H or 10H or 20H or 30H

#### 5.3 Functions of Block Lock and Block Lock-Down

		(2)			
State	F-WP	$DQ_1^{(1)}$	$DQ_0^{(1)}$	State Name	Erase/Program Allowed (2)
[000]	0	0	0	Unlocked	Yes
[001] <sup>(3)</sup>	0	0	1	Locked	No
[011]	0	1	1	Locked-down	No
[100]	1	0	0	Unlocked	Yes
[101] <sup>(3)</sup>	1	0	1	Locked	No
[110] <sup>(4)</sup>	1	1	0	Lock-down Disable	Yes
[111]	1	1	1	Lock-down Disable	No

#### Notes:

- 1.  $DQ_0 = 1$ : a block is locked;  $DQ_0 = 0$ : a block is unlocked.  $DQ_1 = 1$ : a block is locked-down;  $DQ_1 = 0$ : a block is not locked-down.
- 2. Erase and program are general terms, respectively, to express: block erase, full chip erase and (page buffer) program operations.
- 3. At power-up or device reset, all blocks default to locked state and are not locked-down, that is, [001] (F- $\overline{\text{WP}} = 0$ ) or [101] (F- $\overline{\text{WP}} = 1$ ), regardless of the states before power-off or reset operation.
- 4. When  $F-\overline{WP}$  is driven to  $V_{IL}$  in [110] state, the state changes to [011] and the blocks are automatically locked.

# 5.4 Block Locking State Transitions upon Command Write<sup>(4)</sup>

	Current State			Result after Lock Command Written (Next State)			
State	F-WP	DQ <sub>1</sub>	$DQ_0$	Set Lock <sup>(1)</sup>	Clear Lock <sup>(1)</sup>	Set Lock-down <sup>(1)</sup>	
[000]	0	0	0	[001]	No Change	[011] <sup>(2)</sup>	
[001]	0	0	1	No Change <sup>(3)</sup>	[000]	[011]	
[011]	0	1	1	No Change	No Change	No Change	
[100]	1	0	0	[101]	No Change	[111] <sup>(2)</sup>	
[101]	1	0	1	No Change	[100]	[111]	
[110]	1	1	0	[111]	No Change	[111] <sup>(2)</sup>	
[111]	1	1	1	No Change	[110]	No Change	

- 1. "Set Lock" means Set Block Lock Bit command, "Clear Lock" means Clear Block Lock Bit command and "Set Lock-down" means Set Block Lock-Down Bit command.
- 2. When the Set Block Lock-Down Bit command is written to the unlocked block ( $DQ_0 = 0$ ), the corresponding block is locked-down and automatically locked at the same time.
- 3. "No Change" means that the state remains unchanged after the command written.
- 4. In this state transitions table, assumes that F- $\overline{WP}$  is not changed and fixed  $V_{IL}$  or  $V_{IH}$ .

# 5.5 Block Locking State Transitions upon F-WP Transition<sup>(4)</sup>

<b>D</b> : C( )		Current State			Result after F-WP Transition (Next State)		
Previous State	State	F-WP	DQ <sub>1</sub>	$DQ_0$	$F-\overline{WP} = 0 \rightarrow 1^{(1)}$	$F-\overline{WP}=1\rightarrow 0^{(1)}$	
-	[000]	0	0	0	[100]	-	
-	[001]	0	0	1	[101]	-	
[110] <sup>(2)</sup>	[011]	0	1	1	[110]	-	
Other than [110] <sup>(2)</sup>	[011]	U	1	1	[111]	-	
-	[100]	1	0	0	-	[000]	
-	[101]	1	0	1	-	[001]	
-	[110]	1	1	0	-	[011] <sup>(3)</sup>	
-	[111]	1	1	1	-	[011]	

- 1. "F- $\overline{WP} = 0 \rightarrow 1$ " means that F- $\overline{WP}$  is driven to  $V_{IH}$  and "F- $\overline{WP} = 1 \rightarrow 0$ " means that F- $\overline{WP}$  is driven to  $V_{IL}$ .
- 2. State transition from the current state [011] to the next state depends on the previous state.
- 3. When  $F-\overline{WP}$  is driven to  $V_{IL}$  in [110] state, the state changes to [011] and the blocks are automatically locked.
- 4. In this state transitions table, assumes that lock configuration commands are not written in previous, current and next state.

#### 6. Status Register Definition

# Status Register Definition

R	R	R	R	R	R	R	R
15	14	13	12	11	10	9	8
WSMS	BESS	BEFCES	PBPS	VPPS	PBPSS	DPS	R
7	6	5	4	3	2	1	0

## SR.15 - SR.8 = RESERVED FOR FUTURE ENHANCEMENTS (R)

SR.7 = WRITE STATE MACHINE STATUS (WSMS)

1 = Ready

0 = Busy

SR.6 = BLOCK ERASE SUSPEND STATUS (BESS)

1 = Block Erase Suspended

0 = Block Erase in Progress/Completed

SR.5 = BLOCK ERASE AND FULL CHIP ERASE STATUS (BEFCES)

1 = Error in Block Erase or Full Chip Erase

0 = Successful Block Erase or Full Chip Erase

SR.4 = (PAGE BUFFER) PROGRAM STATUS (PBPS)

1 = Error in (Page Buffer) Program

0 = Successful (Page Buffer) Program

 $SR.3 = F-V_{PP} STATUS (VPPS)$ 

 $1 = F-V_{PP}$  LOW Detect, Operation Abort

 $0 = F - V_{pp} OK$ 

SR.2 = (PAGE BUFFER) PROGRAM SUSPEND STATUS (PBPSS)

1 = (Page Buffer) Program Suspended

0 = (Page Buffer) Program in Progress/Completed

SR.1 = DEVICE PROTECT STATUS (DPS)

1 = Erase or Program Attempted on a Locked Block, Operation Abort

0 = Unlocked

SR.0 = RESERVED FOR FUTURE ENHANCEMENTS (R)

Notes:

Status Register indicates the status of the partition, not WSM (Write State Machine). Even if the SR.7 is "1", the WSM may be occupied by the other partition when the device is set to 2, 3 or 4 partitions configuration.

Check SR.7 or  $F-RY/\overline{BY}$  to determine block erase, full chip erase, (page buffer) program completion. SR.6 - SR.1 are invalid while SR.7="0".

If both SR.5 and SR.4 are "1"s after a block erase, full chip erase, page buffer program, set/clear block lock bit, set block lock-down bit or set partition configuration register attempt, an improper command sequence was entered.

SR.3 does not provide a continuous indication of F-V<sub>PP</sub> level. The WSM interrogates and indicates the F-V<sub>PP</sub> level only after Block Erase, Full Chip Erase, (Page Buffer) Program command sequences. SR.3 is not guaranteed to report accurate feedback when F-V<sub>PP</sub> $\neq$ V<sub>PPH1/2</sub> or V<sub>PPLK</sub>.

SR.1 does not provide a continuous indication of block lock bit. The WSM interrogates the block lock bit only after Block Erase, Full Chip Erase, (Page Buffer) Program command sequences. It informs the system, depending on the attempted operation, if the block lock bit is set. Reading the block lock configuration codes after writing the Read Identifier Codes command indicates block lock bit status.

SR.15 - SR.8 and SR.0 are reserved for future use and should be masked out when polling the status register.

		E	xtended Status I	Register Definiti	on		
R	R	R	R	R	R	R	R
15	14	13	12	11	10	9	8
SMS	R	R	R	R	R	R	R
7	6	5	4	3	2	1	0

XSR.15-8 = RESERVED FOR FUTURE ENHANCEMENTS (R)

XSR.7 = STATE MACHINE STATUS (SMS)

1 = Page Buffer Program available

0 = Page Buffer Program not available

XSR.6-0 = RESERVED FOR FUTURE ENHANCEMENTS (R)

Notes:

After issue a Page Buffer Program command (E8H), XSR.7="1" indicates that the entered command is accepted. If XSR.7 is "0", the command is not accepted and a next Page Buffer Program command (E8H) should be issued again to check if page buffer is available or not.

XSR.15-8 and XSR.6-0 are reserved for future use and should be masked out when polling the extended status register.

		Partit	ion Configuration	on Register Defi	nition		
R	R	R	R	R	PC2	PC1	PC0
15	14	13	12	11	10	9	8
R	R	R	R	R	R	R	R
7	6	5	4	3	2	1	0

## PCR.15-11 = RESERVED FOR FUTURE ENHANCEMENTS (R)

#### PCR.10-8 = PARTITION CONFIGURATION (PC2-0)

- 000 = No partitioning. Dual Work is not allowed.
- 001 = Plane1-3 are merged into one partition. (default in a bottom parameter device)
- 010 = Plane 0-1 and Plane2-3 are merged into one partition respectively.
- 100 = Plane 0-2 are merged into one partition. (default in a top parameter device)
- 011 = Plane 2-3 are merged into one partition. There are three partitions in this configuration. Dual work operation is available between any two partitions.
- 110 = Plane 0-1 are merged into one partition. There are three partitions in this configuration. Dual work See the table below for more details. operation is available between any two partitions.
- 101 = Plane 1-2 are merged into one partition. There are three partitions in this configuration. Dual work operation is available between any two partitions.

111 = There are four partitions in this configuration. Each plane corresponds to each partition respectively. Dual work operation is available between any two partitions.

PCR.7-0 = RESERVED FOR FUTURE ENHANCEMENTS (R)

#### Notes:

After power-up or device reset, PCR10-8 (PC2-0) is set to "001" in a bottom parameter device and "100" in a top parameter device.

PCR.15-11 and PCR.7-0 are reserved for future use and should be masked out when polling the partition configuration register.

# **Partition Configuration**

PC2 PC1 PC0	PARTITIONING FOR DUAL WORK	PC2 PC1 PC0	PARTITIONING FOR DUAL WORK
0 0 0	PLANE3  PLANE1  PLANE0  PLANE0	0 1 1	PARTITION2 PARTITION1 PARTITION0  BLANE  BLA
0 0 1	DITITION INDITITION INDITION INDITITION INDITITION INDITITION INDITION INDITITION INDITITION INDITITION INDITION INDITITION INDITION INDITITION INDITION	1 1 0	PARTITION2 PARTITION1 PARTITION0    Carry   Ca
0 1 0	0/4 DEANE 0/4 DE	1 0 1	PARTITION2 PARTITION1 PARTITION0  EAU  BLANE  BLANE
1 0 0	PARTITION I PARTIT	1 1 1	PARTITION3 PARTITION2 PARTITION1 PARTITION0  EN PARTITION PARTITIO



- 7. Memory Map for Flash Memory
- 7.1 Memory Map  $F_1$  Selected ( $F_1$ - $\overline{CE}$  = "L",  $F_2$ - $\overline{CE}$  = "H")

# **Bottom Parameter**

# BLOCK NUMBER ADDRESS RANGE

			_
	134	32K-WORD	3F8000H - 3FFFFFH
	133	32K-WORD	3F0000H - 3F7FFFH
	132	32K-WORD	3E8000H - 3EFFFFH
	131	32K-WORD	3E0000H - 3E7FFFH
	130	32K-WORD	3D8000H - 3DFFFFH
	129	32K-WORD	3D0000H - 3D7FFFH
	128	32K-WORD	3C8000H - 3CFFFFH
	127	32K-WORD	3C0000H - 3C7FFFH
<u></u>	126	32K-WORD	3B8000H - 3BFFFFH
ピ	125	32K-WORD	3B0000H - 3B7FFFH
PLANE3 (UNIFORM PLANE	124	32K-WORD	3A8000H - 3AFFFFH
٦	123	32K-WORD	3A0000H - 3A7FFFH
	122	32K-WORD	398000H - 39FFFFH
ĮΣ	121	32K-WORD	390000H - 397FFFH
쏮	120	32K-WORD	388000H - 38FFFFH
ΙÔ	119	32K-WORD	380000H - 387FFFH
IË	118	32K-WORD	378000H - 37FFFFH
	117	32K-WORD	370000H - 377FFFH
<u>し</u>	116	32K-WORD	368000H - 36FFFFH
<i>ω</i>	115	32K-WORD	360000H - 367FFFH
門	114	32K-WORD	358000H - 35FFFFH
#	113	32K-WORD	350000H - 357FFFH
ادًا	112	32K-WORD	348000H - 34FFFFH
_	111	32K-WORD	340000H - 347FFFH
	110	32K-WORD	338000H - 33FFFFH
	109	32K-WORD	330000H - 337FFFH
	108	32K-WORD	328000H - 32FFFFH
	107	32K-WORD	320000H - 327FFFH
	106	32K-WORD	318000H - 31FFFFH
	105	32K-WORD	310000H - 317FFFH
	104	32K-WORD	308000H - 30FFFFH
	103	32K-WORD	300000H - 307FFFH

	102	32K-WORD	2F8000H - 2FFFFFH
	101	32K-WORD	2F0000H - 2F7FFFH
	100	32K-WORD	2E8000H - 2EFFFFH
	99	32K-WORD	2E0000H - 2E7FFFH
	98	32K-WORD	2D8000H - 2DFFFFH
	97	32K-WORD	2D0000H - 2D7FFFH
	96	32K-WORD	2C8000H - 2CFFFFH
	95	32K-WORD	2C0000H - 2C7FFFH
	94	32K-WORD	2B8000H - 2BFFFFH
田川	93	32K-WORD	2B0000H - 2B7FFFH
Z	92	32K-WORD	2A8000H - 2AFFFFH
(UNIFORM PLANE	91	32K-WORD	2A0000H - 2A7FFFH
Ы	90	32K-WORD	298000H - 29FFFFH
7	89	32K-WORD	290000H - 297FFFH
[☆]	88	32K-WORD	288000H - 28FFFFH
15.	87	32K-WORD	280000H - 287FFFH
臣.	86	32K-WORD	278000H - 27FFFFH
١Z .	85	32K-WORD	270000H - 277FFFH
	84	32K-WORD	268000H - 26FFFFH
	83	32K-WORD	260000H - 267FFFH
邑	82	32K-WORD	258000H - 25FFFFH
PLANE2	81	32K-WORD	250000H - 257FFFH
اح	80	32K-WORD	248000H - 24FFFFH
딢	79	32K-WORD	240000H - 247FFFH
l `	78	32K-WORD	238000H - 23FFFFH
	77	32K-WORD	230000H - 237FFFH
	76	32K-WORD	228000H - 22FFFFH
	75	32K-WORD	220000H - 227FFFH
	74	32K-WORD	218000H - 21FFFFH
	73	32K-WORD	210000H - 217FFFH
	72	32K-WORD	208000H - 20FFFFH
	71	32K-WORD	200000H - 207FFFH

# BLOCK NUMBER ADDRESS RANGE

			_
	70	32K-WORD	1F8000H - 1FFFFFH
	69	32K-WORD	1F0000H - 1F7FFFH
	68	32K-WORD	1E8000H - 1EFFFFH
	67	32K-WORD	1E0000H - 1E7FFFH
	66	32K-WORD	1D8000H - 1DFFFFH
	65	32K-WORD	1D0000H - 1D7FFFH
	64	32K-WORD	1C8000H - 1CFFFFH
	63	32K-WORD	1C0000H - 1C7FFFH
$\Xi$	62	32K-WORD	1B8000H - 1BFFFFH
Z	61	32K-WORD	1B0000H - 1B7FFFH
(UNIFORM PLANE	60	32K-WORD	1A8000H - 1AFFFFH
	59	32K-WORD	1A0000H - 1A7FFFH
1.	58	32K-WORD	198000H - 19FFFFH
	57	32K-WORD	190000H - 197FFFH
J.	56	32K-WORD	188000H - 18FFFFH
$\mathbf{F}$	55	32K-WORD	180000H - 187FFFH
ΙĦ	54	32K-WORD	178000H - 17FFFFH
15	53	32K-WORD	170000H - 177FFFH
	52	32K-WORD	168000H - 16FFFFH
[1]	51	32K-WORD	160000H - 167FFFH
15	50	32K-WORD	158000H - 15FFFFH
PLANE1	49	32K-WORD	150000H - 157FFFH
Ţ	48	32K-WORD	148000H - 14FFFFH
1	47	32K-WORD	140000H - 147FFFH
	46	32K-WORD	138000H - 13FFFFH
	45	32K-WORD	130000H - 137FFFH
	44	32K-WORD	128000H - 12FFFFH
	43	32K-WORD	120000H - 127FFFH
	42	32K-WORD	118000H - 11FFFFH
	41	32K-WORD	110000H - 117FFFH
	40	32K-WORD	108000H - 10FFFFH
	39	32K-WORD	100000H - 107FFFH
	_		_

32K-WORD				
32K-WORD		38	32K-WORD	
35   32K-WORD   0E0000H - 0E7FFFH   34   32K-WORD   0D0000H - 0D7FFFF   33   32K-WORD   0C8000H - 0D7FFFH   32   32K-WORD   0C8000H - 0C7FFFH   30   32K-WORD   0B8000H - 0BFFFFH   30   32K-WORD   0B8000H - 0BFFFFH   28   32K-WORD   0B8000H - 0AFFFFH   28   32K-WORD   0A8000H - 0AFFFFH   25   32K-WORD   098000H - 097FFFH   25   32K-WORD   098000H - 097FFFH   24   32K-WORD   088000H - 08FFFFH   22   32K-WORD   088000H - 08FFFFH   21   32K-WORD   078000H - 077FFFH   21   32K-WORD   078000H - 077FFFH   21   32K-WORD   068000H - 06FFFFH   20   32K-WORD   068000H - 06FFFFH   21   32K-WORD   068000H - 05FFFFH   21   32K-WORD   068000H - 05FFFFH   21   32K-WORD   068000H - 05FFFFH   21   32K-WORD   058000H - 05FFFFH   21   32K-WORD   068000H - 05FFFFH   21   32K-WORD   058000H - 05FFFFH   21   32K-WORD   018000H - 047FFFFH   21   32K-WORD   018000H - 047FFFFH   21   32K-WORD   018000H - 037FFFFH   21   32K-WORD   018000H - 037FFFFH   21   32K-WORD   018000H - 017FFFFH   21   32K-WORD   018000H - 007FFFFH   21   32K-WORD   003000H - 003FFFFH   21   32K-WORD   003000H - 003FFFFH		37	32K-WORD	0F0000H - 0F7FFFH
32K-WORD		36	32K-WORD	0E8000H - 0EFFFFH
33 32K-WORD		35	32K-WORD	0E0000H - 0E7FFFH
32 32K-WORD   0C8000H - 0CFFFFH   31 32K-WORD   0C8000H - 0CFFFFH   30 32K-WORD   0B8000H - 0BFFFFH   28 32K-WORD   0B8000H - 0BFFFFH   27 32K-WORD   0A8000H - 0AFFFFH   26 32K-WORD   098000H - 09FFFFH   24 32K-WORD   098000H - 09FFFFH   21 32K-WORD   080000H - 08FFFFH   22 32K-WORD   078000H - 08FFFFH   21 32K-WORD   078000H - 07FFFFH   21 32K-WORD   078000H - 07FFFFH   21 32K-WORD   068000H - 06FFFFH   20 32K-WORD   068000H - 06FFFFH   21 32K-WORD   078000H - 07FFFFH   21 32K-WORD   068000H - 06FFFFH   21 32K-WORD   058000H - 05FFFFH   21 32K-WORD   058000H - 05FFFFH   21 32K-WORD   048000H - 04FFFFH   21 32K-WORD   048000H - 04FFFFH   21 32K-WORD   038000H - 03FFFFH   21 32K-WORD   038000H - 03FFFFH   21 32K-WORD   038000H - 03FFFFH   21 32K-WORD   028000H - 02FFFFH   21 32K-WORD   018000H - 02FFFFH   21 32K-WORD   018000H - 01FFFFH   21 32K-WORD   008000H - 01FFFFH   21 32K-WORD   008000H - 007FFFH   21 32K-WORD   008000H - 003FFFH   21 32K-WORD   00800H - 003FFFH   21 32K-WOR		34	32K-WORD	0D8000H - 0DFFFFH
31 32K-WORD   0C0000H - 0C7FFFH		33	32K-WORD	0D0000H - 0D7FFFH
32K-WORD		32	32K-WORD	0C8000H - 0CFFFFH
29 32K-WORD		31	32K-WORD	0C0000H - 0C7FFFH
28 32K-WORD		30	32K-WORD	0B8000H - 0BFFFFH
1		29	32K-WORD	0B0000H - 0B7FFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH		28	32K-WORD	0A8000H - 0AFFFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	円	27	32K-WORD	0A0000H - 0A7FFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH		26	32K-WORD	098000H - 09FFFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	تدا	25	32K-WORD	090000H - 097FFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	<u> </u>	24	32K-WORD	088000H - 08FFFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	24	23	32K-WORD	080000H - 087FFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	lΞ	22	32K-WORD	078000H - 07FFFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	ΙŒ	21	32K-WORD	070000H - 077FFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	lΣ	20	32K-WORD	068000H - 06FFFFH
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	<b>I</b> Z	19	32K-WORD	
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH			32K-WORD	
10 32K-WORD 018000H - 01FFFFH 9 32K-WORD 018000H - 01FFFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 5 4K-WORD 005000H - 005FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 003000H - 003FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH 1 001000H - 001FFFH 1 001000H - 001FFFH	조	17	32K-WORD	050000H - 057FFFH
11   32K-WORD   0200011   271111   10   32K-WORD   018000H - 01FFFFH   9   32K-WORD   010000H - 017FFFH   8   32K-WORD   008000H - 00FFFFH   7   4K-WORD   007000H - 007FFFH   5   4K-WORD   006000H - 006FFFH   5   4K-WORD   005000H - 005FFFH   4   4K-WORD   004000H - 004FFFH   3   4K-WORD   003000H - 003FFFH   2   4K-WORD   002000H - 002FFFH   1   4K-WORD   001000H - 001FFFH   1   4K-WORD   00100H - 00100H   1   1   1	(F)	16	32K-WORD	
11   32K-WORD   0200011   271111   10   32K-WORD   018000H - 01FFFFH   9   32K-WORD   010000H - 017FFFH   8   32K-WORD   008000H - 00FFFFH   7   4K-WORD   007000H - 007FFFH   5   4K-WORD   006000H - 006FFFH   5   4K-WORD   005000H - 005FFFH   4   4K-WORD   004000H - 004FFFH   3   4K-WORD   003000H - 003FFFH   2   4K-WORD   002000H - 002FFFH   1   4K-WORD   001000H - 001FFFH   1   4K-WORD   00100H - 00100H   1   1   1	18	15	32K-WORD	040000H - 047FFFH
11   32K-WORD   0200011   271111   10   32K-WORD   018000H - 01FFFFH   9   32K-WORD   010000H - 017FFFH   8   32K-WORD   008000H - 00FFFFH   7   4K-WORD   007000H - 007FFFH   5   4K-WORD   006000H - 006FFFH   5   4K-WORD   005000H - 005FFFH   4   4K-WORD   004000H - 004FFFH   3   4K-WORD   003000H - 003FFFH   2   4K-WORD   002000H - 002FFFH   1   4K-WORD   001000H - 001FFFH   1   4K-WORD   00100H - 00100H   1   1   1	門	14	32K-WORD	038000H - 03FFFFH
11   32K-WORD   0200011   271111   10   32K-WORD   018000H - 01FFFFH   9   32K-WORD   010000H - 017FFFH   8   32K-WORD   008000H - 00FFFFH   7   4K-WORD   007000H - 007FFFH   5   4K-WORD   006000H - 006FFFH   5   4K-WORD   005000H - 005FFFH   4   4K-WORD   004000H - 004FFFH   3   4K-WORD   003000H - 003FFFH   2   4K-WORD   002000H - 002FFFH   1   4K-WORD   001000H - 001FFFH   1   4K-WORD   00100H - 00100H   1   1   1	🗇	13	32K-WORD	030000H - 037FFFH
11   32K-WORD   0200011   271111   10   32K-WORD   018000H - 01FFFFH   9   32K-WORD   010000H - 017FFFH   8   32K-WORD   008000H - 00FFFFH   7   4K-WORD   007000H - 007FFFH   5   4K-WORD   006000H - 006FFFH   5   4K-WORD   005000H - 005FFFH   4   4K-WORD   004000H - 004FFFH   3   4K-WORD   003000H - 003FFFH   2   4K-WORD   002000H - 002FFFH   1   4K-WORD   001000H - 001FFFH   1   4K-WORD   00100H - 00100H   1   1   1	Ľ	12	32K-WORD	028000H - 02FFFFH
9 32K-WORD 010000H - 017FFFH 8 32K-WORD 008000H - 00FFFFH 7 4K-WORD 007000H - 007FFFH 6 4K-WORD 006000H - 006FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH	Ъ	11	32K-WORD	020000H - 027FFFH
8         32K-WORD         008000H - 00FFFFH           7         4K-WORD         007000H - 007FFFH           6         4K-WORD         006000H - 005FFFH           5         4K-WORD         005000H - 005FFFH           4         4K-WORD         004000H - 004FFFH           3         4K-WORD         003000H - 002FFFH           2         4K-WORD         002000H - 002FFFH           1         4K-WORD         001000H - 001FFFH		10	32K-WORD	018000H - 01FFFFH
7 4K-WORD 007000H - 007FFFH 6 4K-WORD 006000H - 006FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH		9	32K-WORD	010000H - 017FFFH
6 4K-WORD 006000H - 006FFFH 5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH		8	32K-WORD	008000H - 00FFFFH
5 4K-WORD 005000H - 005FFFH 4 4K-WORD 004000H - 004FFFH 3 4K-WORD 003000H - 003FFFH 2 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH		7	4K-WORD	
4 4K-WORD 00400H - 004FFH 3 4K-WORD 003000H - 003FFH 2 4K-WORD 002000H - 002FFH 1 4K-WORD 001000H - 001FFH		6	4K-WORD	
3 4K-WORD 003000H - 003FFFH 2 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH		5	4K-WORD	
2 4K-WORD 002000H - 002FFFH 1 4K-WORD 001000H - 001FFFH			4K-WORD	
1 4K-WORD 001000H - 001FFFH			4K-WORD	
1 III WORLD		2	4K-WORD	
1   0 4K-WORD   1000000H - 000FFFH			4K-WORD	
10 112 110100		0	4K-WORD	000000H - 000FFFH



# 7.2 Memory Map - $F_2$ Selected ( $F_1$ - $\overline{CE}$ = "H", $F_2$ - $\overline{CE}$ = "L")

# Top Parameter

# BLOCK NUMBER ADDRESS RANGE

131		DLO	CKNOWIDEK	ADDRESS KAI
132		134	4K-WORD	
131		133	4K-WORD	3FE000H - 3FEFFFH
130		132	4K-WORD	3FD000H - 3FDFFFH
129		131	4K-WORD	3FC000H - 3FCFFFH
128		130	4K-WORD	3FB000H - 3FBFFFH
127		129	4K-WORD	3FA000H - 3FAFFFH
126 32K-WORD   3F0000H - 3F7FFFH   125 32K-WORD   3E8000H - 3EFFFFH   124 32K-WORD   3E8000H - 3EFFFFH   125 32K-WORD   3D8000H - 3D7FFFH   123 32K-WORD   3D8000H - 3D7FFFH   121 32K-WORD   3C8000H - 3C7FFFH   121 32K-WORD   3C8000H - 3C7FFFH   121 32K-WORD   3B8000H - 3BFFFFH   122 32K-WORD   3B8000H - 3BFFFFH   123 32K-WORD   3B8000H - 3BFFFFH   124 32K-WORD   3A8000H - 3A7FFFH   125 32K-WORD   3A8000H - 3A7FFFH   126 32K-WORD   388000H - 3FFFFH   127 32K-WORD   388000H - 3FFFFH   128 32K-WORD   378000H - 3FFFFH   128 32K-WORD   368000H - 3FFFFH   128 32K-WORD   368000H - 3FFFFH   128 32K-WORD   358000H - 3FFFFH   128 32K-WORD   358000H - 3FFFFH   128 32K-WORD   348000H - 3FFFFH   128 32K-WORD   338000H - 3FFFFH   128 32K-WORD   328000H - 3FFFFH   128 32K-WORD   318000H - 3		128	4K-WORD	3F9000H - 3F9FFFH
125 32K-WORD   3E8000H - 3EFFFH   123 32K-WORD   3D8000H - 3DFFFFH   123 32K-WORD   3D8000H - 3DFFFFH   122 32K-WORD   3D8000H - 3DFFFFH   121 32K-WORD   3C8000H - 3CFFFFH   3C8000H - 3CFFFFH   3ZK-WORD   3C8000H - 3CFFFFH   3ZK-WORD   3B8000H - 3BFFFFH   3ZK-WORD   3B8000H - 3BFFFFH   3ZK-WORD   3A8000H - 3AFFFFH   3ZK-WORD   3A8000H - 3AFFFFH   3ZK-WORD   3A8000H - 3AFFFFH   3ZK-WORD   3B8000H - 3AFFFFH   114 3ZK-WORD   3B8000H - 3BFFFFH   115 3ZK-WORD   3B8000H - 3BFFFFH   116 3ZK-WORD   3B8000H - 3BFFFFH   117 3ZK-WORD   3B8000H - 3BFFFFH   118 3ZK-WORD   3B8000H - 3BFFFFH   119 3ZK-WORD   3T8000H - 3TFFFFH   109 3ZK-WORD   3T8000H - 3FFFFH   106 3ZK-WORD   358000H - 3FFFFH   107 3ZK-WORD   358000H - 3FFFFH   106 3ZK-WORD   348000H - 3FFFFH   107 3ZK-WORD   348000H - 3FFFFH   108 3ZK-WORD   348000H - 3FFFFH   109 3ZK-WORD   348000H - 3FFFFH   101 3ZK-WORD   338000H - 3FFFFH   102 3ZK-WORD   338000H - 3FFFFH   103 3ZK-WORD   328000H - 3ZFFFFH   103 3ZK-WORD   328000H - 3ZFFFFH   103 3ZK-WORD   328000H - 3ZFFFFH   101 3ZK-WORD   328000H - 3ZFFFFH   101 3ZK-WORD   328000H - 3ZFFFFH   102 3ZK-WORD   328000H - 3ZFFFFH   103 3ZK-WORD   318000H - 3ZFFFFH   104 3ZK-WORD   328000H - 3ZFFFFH   105 3ZK-WORD   318000H - 3ZFFFFH   106 3ZK-WORD   318000H - 3ZFFFFH   107 3ZK-WORD   318000H - 3ZFFFFH		127	4K-WORD	3F8000H - 3F8FFFH
124 32K-WORD   3E0000H - 3E7FFFH   123 32K-WORD   3D8000H - 3D7FFFH   121 32K-WORD   3C8000H - 3D7FFFH   120 32K-WORD   3C8000H - 3C7FFFH   120 32K-WORD   3C8000H - 3C7FFFH   110 32K-WORD   3B8000H - 3BFFFFH   117 32K-WORD   3A8000H - 3BFFFFH   116 32K-WORD   3A8000H - 3A7FFFH   115 32K-WORD   3A8000H - 3A7FFFH   116 32K-WORD   380000H - 3A7FFFH   117 32K-WORD   380000H - 3A7FFFH   118 32K-WORD   380000H - 3A7FFFH   119 32K-WORD   380000H - 3FFFFH   110 32K-WORD   380000H - 3FFFFH   111 32K-WORD   380000H - 3FFFFH   110 32K-WORD   370000H - 37FFFFH   110 32K-WORD   370000H - 37FFFFH   111 32K-WORD   370000H - 3FFFFH   111 32K-WORD   370000H - 37FFFFH   111 32K-WORD   370000H - 37FF		126	32K-WORD	3F0000H - 3F7FFFH
123 32K-WORD   3D8000H - 3DFFFFH   121 32K-WORD   3C8000H - 3CFFFFH   120 32K-WORD   3C8000H - 3CFFFFH   121 32K-WORD   3B8000H - 3BFFFFH   118 32K-WORD   3B8000H - 3BFFFFH   117 32K-WORD   3A8000H - 3AFFFFH   116 32K-WORD   3A8000H - 3AFFFFH   115 32K-WORD   398000H - 39FFFFH   114 32K-WORD   398000H - 39FFFFH   115 32K-WORD   388000H - 38FFFFH   112 32K-WORD   388000H - 38FFFFH   112 32K-WORD   388000H - 38FFFFH   112 32K-WORD   378000H - 38FFFFH   112 32K-WORD   378000H - 37FFFFH   110 32K-WORD   378000H - 37FFFFH   110 32K-WORD   368000H - 36FFFFH   106 32K-WORD   368000H - 36FFFFH   107 32K-WORD   350000H - 35FFFFH   106 32K-WORD   348000H - 35FFFFH   107 32K-WORD   348000H - 34FFFFH   108 32K-WORD   348000H - 33FFFFH   109 32K-WORD   338000H - 33FFFFH   101 32K-WORD   338000H - 33FFFFH   102 32K-WORD   338000H - 33FFFFH   101 32K-WORD   328000H - 33FFFFH   101 32K-WORD   318000H - 33FFFFH   101 32K-WORD   318000H - 33FFFFH   102 32K-WORD   318000H - 33FFFFH   107 32K-WORD   318000H - 33FFFFH   108 32K-WORD   318000H - 33FFFFH   109 32K-WORD   318000H - 33FFFFH   100 32K-WORD   308000H - 30FFFFH   100 32K-WORD   308000H - 30FFFFH   100 32K-WORD		125	32K-WORD	
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	<u></u>	124	32K-WORD	3E0000H - 3E7FFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	岂	123	32K-WORD	3D8000H - 3DFFFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	12	122	32K-WORD	3D0000H - 3D7FFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	انا	121	32K-WORD	3C8000H - 3CFFFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	Ι:	120	32K-WORD	3C0000H - 3C7FFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	18	119	32K-WORD	3B8000H - 3BFFFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	III.	118	32K-WORD	3B0000H - 3B7FFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	山	117	32K-WORD	3A8000H - 3AFFFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	Σ	116	32K-WORD	3A0000H - 3A7FFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	∢	115	32K-WORD	
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	18	114	32K-WORD	390000H - 397FFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	IŽ	113	32K-WORD	388000H - 38FFFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	12	112	32K-WORD	380000H - 387FFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	123	111	32K-WORD	378000H - 37FFFFH
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	ΙZ	110	32K-WORD	
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308		109	32K-WORD	
107   32K-WORD   358000H - 35FFFFH   106   32K-WORD   350000H - 35FFFFH   105   32K-WORD   348000H - 347FFFH   104   32K-WORD   338000H - 337FFFH   102   32K-WORD   338000H - 337FFFH   101   32K-WORD   328000H - 32FFFFH   100   32K-WORD   320000H - 327FFFH   100   32K-WORD   318000H - 31FFFFH   99   32K-WORD   318000H - 31FFFFH   98   32K-WORD   318000H - 317FFFH   97   32K-WORD   308000H - 30FFFFH   98   32K-WORD   308000H   30800H   308	١Ă	108	32K-WORD	
105 32K-WORD   348000H - 34FFFFH   104 32K-WORD   340000H - 347FFFH   103 32K-WORD   338000H - 33FFFFH   102 32K-WORD   338000H - 32FFFFH   101 32K-WORD   328000H - 32FFFFH   100 32K-WORD   318000H - 32FFFFH   99 32K-WORD   318000H - 31FFFFH   98 32K-WORD   318000H - 317FFFH   97 32K-WORD   308000H - 30FFFFH   97 32K-WORD   308000H - 30FFFFH   97 32K-WORD   308000H - 30FFFFH   32K-WORD   308000H   308000H   30800H   30800	Ι"	107	32K-WORD	
104         32K-WORD         340000H - 347FFFH           103         32K-WORD         338000H - 33FFFFH           102         32K-WORD         330000H - 337FFFH           101         32K-WORD         328000H - 32FFFFH           100         32K-WORD         320000H - 327FFFH           99         32K-WORD         318000H - 31FFFFH           98         32K-WORD         310000H - 317FFFH           97         32K-WORD         308000H - 30FFFFH		106	32K-WORD	350000H - 357FFFH
103         32K-WORD         338000H - 33FFFH           102         32K-WORD         330000H - 337FFFH           101         32K-WORD         328000H - 32FFFFH           100         32K-WORD         320000H - 32FFFFH           99         32K-WORD         318000H - 31FFFFH           98         32K-WORD         310000H - 317FFFH           97         32K-WORD         308000H - 30FFFFH		105	32K-WORD	348000H - 34FFFFH
102         32K-WORD         330000H - 337FFFH           101         32K-WORD         328000H - 32FFFFH           100         32K-WORD         320000H - 327FFFH           99         32K-WORD         318000H - 31FFFFH           98         32K-WORD         310000H - 317FFFH           97         32K-WORD         308000H - 30FFFFH			32K-WORD	
101 32K-WORD   328000H - 32FFFFH   100 32K-WORD   320000H - 327FFFH   99 32K-WORD   318000H - 31FFFFH   98 32K-WORD   308000H - 30FFFFH   97 32K-WORD   308000H - 30FFFFH		103	32K-WORD	
100     32K-WORD     320000H - 327FFFH       99     32K-WORD     318000H - 31FFFFH       98     32K-WORD     310000H - 317FFFH       97     32K-WORD     308000H - 30FFFFH		102	32K-WORD	
99 32K-WORD 318000H - 31FFFH 98 32K-WORD 310000H - 317FFFH 97 32K-WORD 308000H - 30FFFFH		101	32K-WORD	328000H - 32FFFFH
98 32K-WORD 310000H - 317FFFH 97 32K-WORD 308000H - 30FFFFH		100	32K-WORD	320000H - 327FFFH
97 32K-WORD 308000H - 30FFFFH	1	99	32K-WORD	318000H - 31FFFFH
	1	98	32K-WORD	310000H - 317FFFH
	1	97	32K-WORD	
96 32K-WORD 300000H - 307FFFH		96	32K-WORD	300000H - 307FFFH

_			_
	95	32K-WORD	2F8000H - 2FFFFFH
	94	32K-WORD	2F0000H - 2F7FFFH
	93	32K-WORD	2E8000H - 2EFFFFH
	92	32K-WORD	2E0000H - 2E7FFFH
	91	32K-WORD	2D8000H - 2DFFFFH
	90	32K-WORD	2D0000H - 2D7FFFH
	89	32K-WORD	2C8000H - 2CFFFFH
	88	32K-WORD	2C0000H - 2C7FFFH
_ [	87	32K-WORD	2B8000H - 2BFFFFH
lΩ	86	32K-WORD	2B0000H - 2B7FFFH
z	85	32K-WORD	2A8000H - 2AFFFFH
🍕	84	32K-WORD	2A0000H - 2A7FFFH
딥	83	32K-WORD	298000H - 29FFFFH
<del>-</del>	82	32K-WORD	290000H - 297FFFH
PLANE2 (UNIFORM PLANE	81	32K-WORD	288000H - 28FFFFH
IÄ I	80	32K-WORD	280000H - 287FFFH
E	79	32K-WORD	278000H - 27FFFFH
ᄓ	78	32K-WORD	270000H - 277FFFH
15	77	32K-WORD	268000H - 26FFFFH
$  \cdot  $	76	32K-WORD	260000H - 267FFFH
18	75	32K-WORD	258000H - 25FFFFH
ΙZΙ	74	32K-WORD	250000H - 257FFFH
[▼]	73	32K-WORD	248000H - 24FFFFH
닏	72	32K-WORD	240000H - 247FFFH
	71	32K-WORD	238000H - 23FFFFH
	70	32K-WORD	230000H - 237FFFH
	69	32K-WORD	228000H - 22FFFFH
	68	32K-WORD	220000H - 227FFFH
	67	32K-WORD	218000H - 21FFFFH
	66	32K-WORD	210000H - 217FFFH
	65	32K-WORD	208000H - 20FFFFH
	64	32K-WORD	200000H - 207FFFH

# BLOCK NUMBER ADDRESS RANGE

	63	32K-WORD	1F8000H - 1FFFFFH
1	62	32K-WORD	1F0000H - 1F7FFFH
	61	32K-WORD	1E8000H - 1EFFFFH
1	60	32K-WORD	1E0000H - 1E7FFFH
	59	32K-WORD	1D8000H - 1DFFFFH
	58	32K-WORD	1D0000H - 1D7FFFH
1	57	32K-WORD	1C8000H - 1CFFFFH
1	56	32K-WORD	1C0000H - 1C7FFFH
	55	32K-WORD	1B8000H - 1BFFFFH
周	54	32K-WORD	1B0000H - 1B7FFFH
	53	32K-WORD	1A8000H - 1AFFFFH
Ľ	52	32K-WORD	1A0000H - 1A7FFFH
<u> </u>	51	32K-WORD	198000H - 19FFFFH
lΣ	50	32K-WORD	190000H - 197FFFH
PLANE1 (UNIFORM PLANE)	49	32K-WORD	188000H - 18FFFFH
	48	32K-WORD	180000H - 187FFFH
ΙĦ	47	32K-WORD	178000H - 17FFFFH
	46	32K-WORD	170000H - 177FFFH
12	45	32K-WORD	168000H - 16FFFFH
I —	44	32K-WORD	160000H - 167FFFH
周	43	32K-WORD	158000H - 15FFFFH
14	42	32K-WORD	150000H - 157FFFH
	41	32K-WORD	148000H - 14FFFFH
	40	32K-WORD	140000H - 147FFFH
	39	32K-WORD	138000H - 13FFFFH
	38	32K-WORD	130000H - 137FFFH
	37	32K-WORD	128000H - 12FFFFH
	36	32K-WORD	120000H - 127FFFH
	35	32K-WORD	118000H - 11FFFFH
	34	32K-WORD	110000H - 117FFFH
1	33	32K-WORD	108000H - 10FFFFH
	32	32K-WORD	100000H - 107FFFH
			_

	31	32K-WORD	0F8000H - 0FFFFFH
	30	32K-WORD	0F0000H - 0F7FFFH
	29	32K-WORD	0E8000H - 0EFFFFH
	28	32K-WORD	0E0000H - 0E7FFFH
	27	32K-WORD	0D8000H - 0DFFFFH
	26	32K-WORD	0D0000H - 0D7FFFH
	25	32K-WORD	0C8000H - 0CFFFFH
	24	32K-WORD	0C0000H - 0C7FFFH
_	23	32K-WORD	0B8000H - 0BFFFFH
回	22	32K-WORD	0B0000H - 0B7FFFH
Z	21	32K-WORD	0A8000H - 0AFFFFH
🍕	20	32K-WORD	0A0000H - 0A7FFFH
ᆸ	19	32K-WORD	098000H - 09FFFFH
∓	18	32K-WORD	090000H - 097FFFH
(UNIFORM PLANE	17	32K-WORD	088000H - 08FFFFH
lΞ	16	32K-WORD	080000H - 087FFFH
E	15	32K-WORD	078000H - 07FFFFH
ᄓ	14	32K-WORD	070000H - 077FFFH
15.	13	32K-WORD	068000H - 06FFFFH
$\subseteq$	12	32K-WORD	060000H - 067FFFH
[읍]	11	32K-WORD	058000H - 05FFFFH
IZ I	10	32K-WORD	050000H - 057FFFH
⋖	9	32K-WORD	048000H - 04FFFFH
PLANE0	8	32K-WORD	040000H - 047FFFH
Ι".	7	32K-WORD	038000H - 03FFFFH
	6	32K-WORD	030000H - 037FFFH
	5	32K-WORD	028000H - 02FFFFH
	4	32K-WORD	020000H - 027FFFH
	3	32K-WORD	018000H - 01FFFFH
	2	32K-WORD	010000H - 017FFFH
	1	32K-WORD	008000H - 00FFFFH
	0	32K-WORD	000000H - 007FFFH

## 8. Absolute Maximum Ratings

Symbol	Parameter	Notes	Ratings	Unit
V <sub>CC</sub>	Supply voltage	1,2	-0.2 to +3.6	V
V <sub>IN</sub>	Input voltage	1,2,3,4	-0.2 to V <sub>CC</sub> +0.3	V
T <sub>A</sub>	Operating temperature		-25 to +85	°C
T <sub>STG</sub>	Storage temperature		-65 to +125	°C
F-V <sub>PP</sub>	F-V <sub>PP</sub> voltage	1,3,5	-0.2 to +12.6	V

#### Notes:

- 1. The maximum applicable voltage on any pins with respect to GND.
- 2. Except F-V<sub>PP</sub>.
- 3. -2.0V undershoot and  $V_{CC}$  +2.0V overshoot are allowed when the pulse width is less than 20 nsec.
- 4.  $V_{IN}$  should not be over 3.6V.
- 5. Applying  $12V \pm 0.3V$  to F-V<sub>PP</sub> during erase/write can only be done for a maximum of 1000 cycles on each block. F-V<sub>PP</sub> may be connected to  $12V \pm 0.3V$  for total of 80 hours maximum.  $\pm 12.6V$  overshoot is allowed when the pulse width is less than 20 nsec.

## 9. Recommended DC Operating Conditions

 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C)$ 

Symbol	Parameter	Notes	Min.	Тур.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	3	2.7	3.0	3.3	V
V <sub>PP</sub>	F-V <sub>PP</sub> Voltage		1.65	3.0	3.3	V
V <sub>IH</sub>	Input Voltage		VCC -0.3 <sup>(2)</sup>		Vcc +0.2 <sup>(1)</sup>	V
$V_{ m IL}$	Input Voltage		-0.2		0.3	V

#### Notes:

- 1.  $V_{CC}$  is the lower of F-V<sub>CC</sub> or S-V<sub>CC</sub>.
- 2.  $V_{CC}$  is the higher of F-V<sub>CC</sub> or S-V<sub>CC</sub>.
- 3.  $V_{CC}$  includes both F- $V_{CC}$  and S- $V_{CC}$ .

# 10. Pin Capacitance<sup>(1)</sup>

 $(T_A = 25^{\circ}C, f = 1MHz)$ 

Symbol	Parameter	Notes	Min.	Тур.	Max.	Unit	Condition
$C_{IN}$	Input capacitance				20	pF	$V_{IN} = 0V$
C <sub>I/O</sub>	I/O capacitance				30	pF	$V_{I/O} = 0V$

# Note:

1. Sampled but not 100% tested.



# 11. DC Electrical Characteristics<sup>(1)</sup>

# DC Electrical Characteristics

 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, V_{CC} = 2.7V \text{ to } 3.3V)$ 

	Input Leakage Curr						
Ir o	Input Leakage Current				±2.5	μΑ	$V_{IN} = V_{CC}$ or GND
1LO	Output Leakage Current				±2.5	μΑ	$V_{OUT} = V_{CC}$ or GND
I <sub>CCS</sub> F	F-V <sub>CC</sub> Standby Cur	rent	2	8	40	μΑ	$F-V_{CC} = F-V_{CC} \text{ Max.,}$ $F-\overline{CE} = F-\overline{RST} = F-V_{CC} \pm 0.2V,$ $F-\overline{WP} = F-V_{CC} \text{ or GND}$
CCAS	F-V <sub>CC</sub> Automatic Current	Power Savings	2,5,8	8	40	μΑ	$F-V_{CC} = F-V_{CC} \text{ Max.},$ $F-\overline{CE} = \text{GND} \pm 0.2V,$ $F-\overline{WP} = F-V_{CC} \text{ or GND}$
I <sub>CCD</sub> F	F-V <sub>CC</sub> Reset Power	-Down Current	2	8	40	μΑ	$\begin{aligned} F-\overline{RST} &= GND \pm 0.2V \\ I_{OUT} \left(F-RY/\overline{BY}\right) &= 0mA \end{aligned}$
F	Average F-V <sub>CC</sub> Read Current Normal Mode		2,8,10	16	26	mA	$F-V_{CC} = F-V_{CC} Max.,$ $F-\overline{CE} = V_{II}, F-\overline{OE} = V_{IH}, f = 5MHz$
F	Average F-V <sub>CC</sub> Read Current Page Mode	8 Word Read	2,8,10	6	11	mA	$I_{OUT} = 0 \text{mA}$
I <sub>CCW</sub> F	F-V <sub>CC</sub> (Page Buffer	r) Program Current	2,6,9,10	21	61	mA	$F-V_{PP} = V_{PPH1}$
1CCW 1	1-vCC (1 age Dune)	) Hogram Current	2,6,9,10	11	21	mA	$F-V_{PP} = V_{PPH2}$
I <sub>CCE</sub> F	F-V <sub>CC</sub> Block Erase	, Full Chip	2,6,9,10	11	31	mA	$F-V_{PP} = V_{PPH1}$
F	Erase Current		2,6,9,10	11	31	mA	$F-V_{PP} = V_{PPH2}$
	F-V <sub>CC</sub> (Page Buffer Block Erase Susper		2,3,10	10	200	μА	$F-\overline{CE} = V_{IH}$
I <sub>PPS</sub> I <sub>PPR</sub>	F-V <sub>PP</sub> Standby or R	ead Current	2,7,10	4	10	μА	$F-V_{PP} \le F-V_{CC}$
I <sub>PPW</sub> F	F-V <sub>PP</sub> (Page Buffer	) Program Current	2,6,7,9,10	2	5	μΑ	$F-V_{PP} = V_{PPH1}$
1ppw 1	r v pp (r uge Burier	) i rogram current	2,6,7,9,10	10	30	mA	$F-V_{PP} = V_{PPH2}$
IDDE	F-V <sub>PP</sub> Block Erase,	Full Chip	2,6,7,9,10	2	5	μΑ	$F-V_{PP} = V_{PPH1}$
FPFE	Erase Current		2,6,7,9,10	5	15	mA	$F-V_{PP} = V_{PPH2}$
DDIVIC	F-V <sub>PP</sub> (Page Buffer) Program		2,7,10	2	5	μΑ	$F-V_{PP} = V_{PPH1}$
rrws S	Suspend Current		2,7,10	10	200	μΑ	$F-V_{PP} = V_{PPH2}$
I <sub>PPES</sub> F	F-V <sub>PP</sub> Block Erase	Suspend Current	2,7,10	2	5	μΑ	$F-V_{PP} = V_{PPH1}$
11123	11 / 222 = 2300	F : 2 33-2 22-3	2,7,10	10	200	μΑ	$F-V_{PP} = V_{PPH2}$

#### DC Electrical Characteristics (Continue)

 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, V_{CC} = 2.7V \text{ to } 3.3V)$ 

Symbol	Parameter	Notes	Min.	Тур.	Max.	Unit	Test Conditions		
$I_{SB}$	S-V <sub>CC</sub> Standby Current				20	μΑ	$S-\overline{CE}_1$ , $S-CE_2 \ge S-V_{CC}$ - 0.2V or $S-CE_2 \le 0.2V$		
I <sub>SB1</sub>	S-V <sub>CC</sub> Standby Current				3	mA	$S-\overline{CE}_1 = V_{IH}, S-CE_2 = V_{IL}$		
I <sub>CC1</sub>	S-V <sub>CC</sub> Operation Current				30	mA	$ \begin{aligned} & S \text{-} \overline{CE}_1 = V_{IL}, \\ & S \text{-} CE_2 = V_{IH}, \\ & V_{IN} = V_{IL} \text{ or } V_{IH} \end{aligned} \qquad \begin{aligned} & t_{CYCLE} = \text{Min.} \\ & I_{I/O} = 0 \text{mA} \end{aligned} $		
I <sub>CC2</sub>	S-V <sub>CC</sub> Operation Current				3	mA	$ \begin{aligned} & S \text{-}\overline{CE}_1 \leq \ 0.2 \text{V}, \\ & S \text{-}CE_2 \geq S \text{-}V_{CC} \text{-}0.2 \text{V}, \\ & V_{IN} \geq S \text{-}V_{CC} \text{-}0.2 \text{V} \\ & \text{or} \leq 0.2 \text{V} \end{aligned}  \begin{aligned} & t_{CYCLE} = 1 \mu \text{s}, \\ & I_{I/O} = 0 \text{mA} \end{aligned} $		
$V_{IL}$	Input Low Voltage	6	-0.2		0.3	V			
V <sub>IH</sub>	Input High Voltage	6	VCC -0.3		VCC +0.2	V			
$V_{OL}$	Output Low Voltage	6			0.4	V	$I_{OL} = 0.5 \text{mA}$		
$V_{OH}$	Output High Voltage	6	2.4			V	$I_{OH} = -0.5 \text{mA}$		
V <sub>PPLK</sub>	F-V <sub>PP</sub> Lockout during Normal Operations	4,6,7			0.4	V			
$V_{PPH1}$	F-V <sub>PP</sub> during Block Erase, Full Chip Erase,(PageBuffer) Program	7	1.65	3	3.3	V			
V <sub>PPH2</sub>	F-V <sub>PP</sub> during Block Erase, (PageBuffer) Program	7	11.7	12	12.3	V			
V <sub>LKO</sub>	F-V <sub>CC</sub> Lockout Voltage		1.5			V			

- 1. V<sub>CC</sub> includes both F-V<sub>CC</sub> and S-V<sub>CC</sub>.
- 2. All currents are in RMS unless otherwise noted. Typical values are the reference values at  $V_{CC} = 3.0 V$  and  $T_A = +25 ^{\circ} C$  unless  $V_{CC}$  is specified.
- 3.  $I_{CCWS}$  and  $I_{CCES}$  are specified with the device de-selected. If read or (page buffer) program while in block erase suspend mode, the device's current draw is the sum of  $I_{CCWS}$  or  $I_{CCES}$  and  $I_{CCR}$  or  $I_{CCW}$ , respectively.
- 4. Block erase, full chip erase, (page buffer) program are inhibited when  $F-V_{PP} \le V_{PPLK}$ , and not guaranteed in the range between  $V_{PPLK}$  (max.) and  $V_{PPH1}$  (min.), between  $V_{PPH1}$  (max.) and  $V_{PPH2}$  (min.) and above  $V_{PPH2}$  (max.).
- 5. The Automatic Power Savings (APS) feature automatically places the device in power save mode after read cycle completion. Standard address access timings (t<sub>AVOV</sub>) provide new data when addresses are changed.
- 6. Sampled, not 100% tested.
- 7. F-V<sub>PP</sub> is not used for power supply pin. With F-V<sub>PP</sub>  $\leq$  V<sub>PPLK</sub>, block erase, full chip erase, (page buffer) program cannot be executed and should not be attempted.
  - Applying  $12V \pm 0.3V$  to  $F-V_{PP}$  provides fast erasing or fast programming mode. In this mode,  $F-V_{PP}$  is power supply pin and supplies the memory cell current for block erasing and (page buffer) programming. Use similar power supply trace widths and layout considerations given to the  $V_{CC}$  power bus.
  - Applying  $12V \pm 0.3V$  to  $F-V_{PP}$  during erase/program can only be done for a maximum of 1000 cycles on each block.  $F-V_{PP}$  may be connected to  $12V \pm 0.3V$  for a total of 80 hours maximum.
- 8. Never hold  $F_1$ - $\overline{CE}$  low and  $F_2$ - $\overline{CE}$  low at the same timing.
- 9. F<sub>1</sub> and F<sub>2</sub> should not be operated at the same timing to Block erase, full chip erase, (page buffer) program.
- 10. The operating current in dual work is the sum of the operating current (read, erase, program) in each plane.

# 12. AC Electrical Characteristics for Flash Memory

## 12.1 AC Test Conditions

Input pulse level	0 V to 2.7 V
Input rise and fall time	5 ns
Input and Output timing Ref. level	1.35 V
Output load	$1TTL + C_L (50pF)$

# 12.2 Read Cycle

 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, F-V_{CC} = 2.7V \text{ to } 3.3V)$ 

Symbol	Parameter	Notes	Min.	Max.	Unit
t <sub>AVAV</sub>	Read Cycle Time		70		ns
t <sub>AVQV</sub>	Address to Output Delay			70	ns
$t_{\rm ELQV}$	F-CE to Output Delay	2		70	ns
t <sub>APA</sub>	Page Address Access Time			25	ns
$t_{GLQV}$	F-OE to Output Delay	2		20	ns
t <sub>PHQV</sub>	F-RST High to Output Delay			150	ns
$t_{EHQZ}, t_{GHQZ}$	F-\overline{\overline{CE}} or F-\overline{\overline{OE}} to Output in High-Z, Whichever Occurs First	1		20	ns
$t_{ELQX}$	F-CE to Output in Low-Z	1	0		ns
$t_{GLQX}$	F-OE to Output in Low-Z	1	0		ns
t <sub>OH</sub>	Output Hold from First Occurring Address, F-\overline{CE} or F-\overline{OE} change	1	0		ns
t <sub>CHCL</sub>	$F_1$ - $\overline{CE}$ High to $F_2$ - $\overline{CE}$ Going Low or $F_2$ - $\overline{CE}$ High to $F_1$ - $\overline{CE}$ Going Low	3	20		ns

- 1. Sampled, not 100% tested.
- 2. F- $\overline{\text{OE}}$  may be delayed up to  $t_{\text{ELQV}} t_{\text{GLQV}}$  after the falling edge of F- $\overline{\text{CE}}$  without impact to  $t_{\text{ELQV}}$
- 3. When reading beyond the Flash chip boundary, t<sub>CHCL</sub> is required from F<sub>1</sub>-\overline{CE} (or F<sub>2</sub>-\overline{CE}) going high to F<sub>2</sub>-\overline{CE} (or F<sub>1</sub>-\overline{CE}) going low.

# 12.3 Write Cycle (F-WE / F-CE Controlled)(1,2,9)

 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, F-V_{CC} = 2.7V \text{ to } 3.3V)$ 

Symbol	Parameter	Notes	Min.	Max.	Unit
$t_{AVAV}$	Write Cycle Time		70		ns
t <sub>PHWL</sub> (t <sub>PHEL</sub> )	F-RST High Recovery to F-WE (F-CE) Going Low	3	150		ns
$t_{\rm ELWL} (t_{\rm WLEL})$	$\overline{F-CE}$ (F- $\overline{WE}$ ) Setup to F- $\overline{WE}$ (F- $\overline{CE}$ ) Going Low	4	0		ns
$t_{WLWH}(t_{ELEH})$	F-WE (F-CE) Pulse Width	4	60		ns
$t_{DVWH} (t_{DVEH})$	Data Setup to F-WE (F-CE) Going High	8	40		ns
$t_{AVWH} (t_{AVEH})$	Address Setup to F-WE (F-CE) Going High	8	50		ns
$t_{WHEH} (t_{EHWH})$	F-CE (F-WE) Hold from F-WE (F-CE) High		0		ns
$t_{WHDX} (t_{EHDX})$	Data Hold from F-WE (F-CE) High		0		ns
$t_{WHAX} (t_{EHAX})$	Address Hold from F-WE (F-CE) High		0		ns
$t_{WHWL} (t_{EHEL})$	F-WE (F-CE) Pulse Width High	5	30		ns
$t_{SHWH} (t_{SHEH})$	F-WP High Setup to F-WE (F-CE) Going High	3	0		ns
$t_{VVWH} (t_{VVEH})$	F-V <sub>PP</sub> Setup to F-WE (F-CE) Going High	3	200		ns
$t_{WHGL} (t_{EHGL})$	Write Recovery before Read		30		ns
$t_{QVSL}$	F-WP High Hold from Valid SRD, F-RY/BY High-Z	3, 6	0		ns
t <sub>QVVL</sub>	F-V <sub>PP</sub> Hold from Valid SRD, F-RY/BY High-Z	3, 6	0		ns
t <sub>WHR0</sub> (t <sub>EHR0</sub> )	F-WE (F-CE) High to SR.7 Going "0"	3, 7		t <sub>AVQV</sub> +40	ns
$t_{WHRL} (t_{EHRL})$	F-WE (F-CE) High to F-RY/BY Going Low	3		100	ns

- 1. The timing characteristics for reading the status register during block erase, full chip erase, (page buffer) program operations are the same as during read-only operations. See the AC Characteristics for read cycle.
- 2. A write operation can be initiated and terminated with either F-\overline{CE} or F-\overline{WE}.
- 3. Sampled, not 100% tested.
- 4. Write pulse width (t<sub>WP</sub>) is defined from the falling edge of F-\overline{CE} or F-\overline{WE} (whichever goes low last) to the rising edge of F-\overline{CE} or F-\overline{WE} (whichever goes high first). Hence, t<sub>WP</sub>=t<sub>WLWH</sub>=t<sub>ELEH</sub>=t<sub>ELWH</sub>.
- 5. Write pulse width high  $(t_{WPH})$  is defined from the rising edge of F- $\overline{CE}$  or F- $\overline{WE}$  (whichever goes high first) to the falling edge of F- $\overline{CE}$  or F- $\overline{WE}$  (whichever goes low last). Hence,  $t_{WPH}$ = $t_{WHWL}$ = $t_{EHEL}$ = $t_{WHEL}$ = $t_{EHWL}$ .
- 6. F-V<sub>PP</sub> should be held at F-V<sub>PP</sub>=V<sub>PPH1/2</sub> until determination of block erase, (page buffer) program success (SR.1/3/4/5=0) and held at F-V<sub>PP</sub>=V<sub>PPH1</sub> until determination of full chip erase success (SR.1/3/5=0).
- 7.  $t_{WHR0} (t_{EHR0})$  after the Read Query or Read Identifier Codes command= $t_{AVQV}$ +100ns.
- 8. See 5.1 Command Definitions for valid address and data for block erase, full chip erase, (page buffer) program or lock bit configuration.
- 9. F<sub>1</sub> and F<sub>2</sub> should not be operated at the same timing to Block erase, full chip erase, (page buffer) program.

# 12.4 Block Erase, Full Chip Erase, (Page Buffer) Program Performance<sup>(3)</sup>

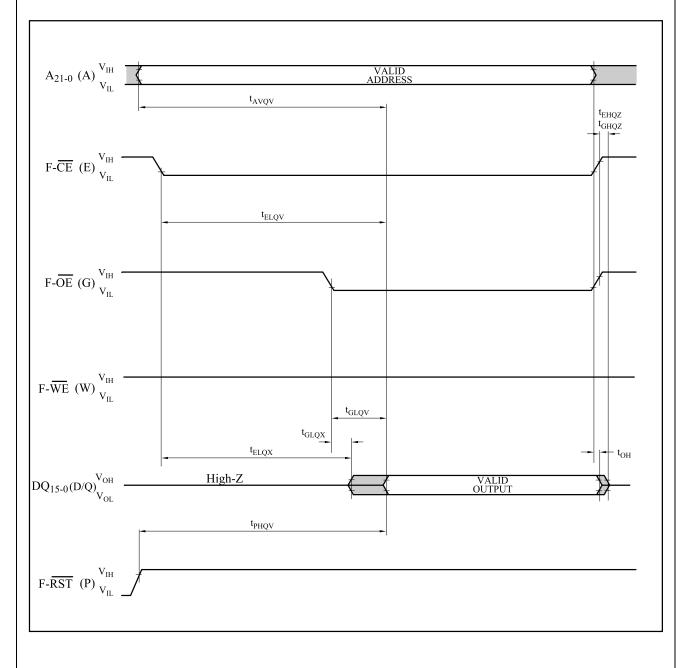
 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, F-V_{CC} = 2.7V \text{ to } 3.3V)$ 

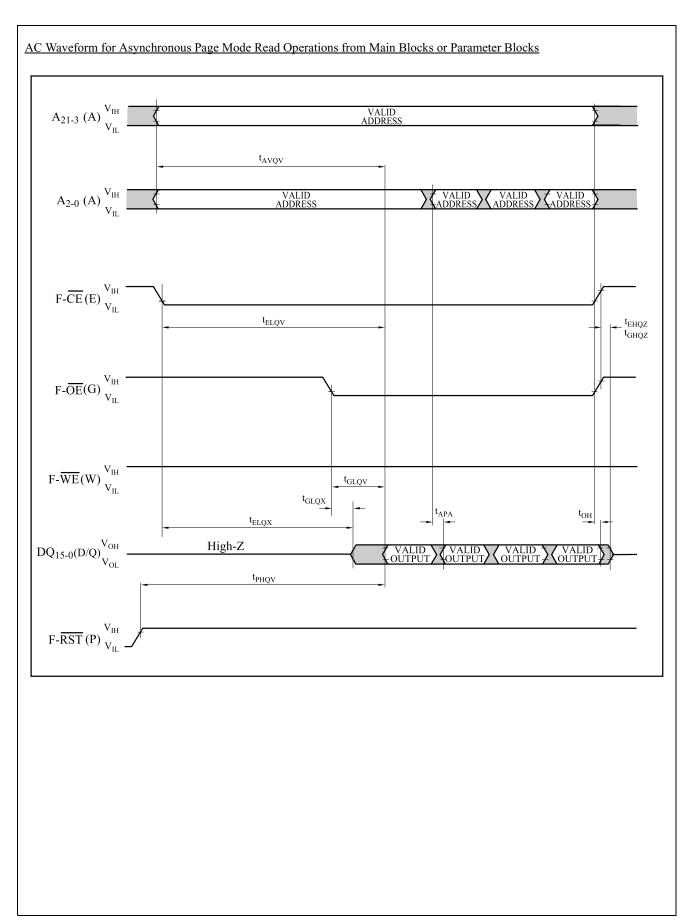
Symbol	Parameter	Notes	Page Buffer Command	F-V <sub>PP</sub> =V <sub>PPH1</sub> (In System)			F- (In 1	Unit		
			is Used or not Used	Min.	Typ.(1)	Max. <sup>(2)</sup>	Min.	Typ.(1)	Max. <sup>(2)</sup>	
$t_{\mathrm{WPB}}$	4K-Word Parameter Block	2	Not Used		0.05	0.3		0.04	0.12	s
WPB	Program Time	2	Used		0.03	0.12		0.02	0.06	s
tun o	32K-Word Main Block	2	Not Used		0.38	2.4		0.31	1	s
t <sub>WMB</sub>	Program Time	2	Used		0.24	1		0.17	0.5	S
t <sub>WHQV1</sub> /	Word Program Time	2	Not Used		11	200		9	185	μs
t <sub>EHQV1</sub>	word Program Time	2	Used		7	100		5	90	μs
t <sub>WHQV2</sub> / t <sub>EHQV2</sub>	4K-Word Parameter Block Erase Time	2	-		0.3	4		0.2	4	s
t <sub>WHQV3</sub> / t <sub>EHQV3</sub>	32K-Word Main Block Erase Time	2	-		0.6	5		0.5	5	s
	Full Chip Erase Time	2			80	700				s
t <sub>WHRH1</sub> / t <sub>EHRH1</sub>	(Page Buffer) Program Suspend Latency Time to Read	4	-		5	10		5	10	μs
t <sub>WHRH2</sub> / t <sub>EHRH2</sub>	Block Erase Suspend Latency Time to Read	4	-		5	20		5	20	μs
t <sub>ERES</sub>	Latency Time from Block Erase Resume Command to Block Erase Suspend Command	5	-	500			500			μs

- 1. Typical values measured at F-V $_{CC}$  =3.0V, F-V $_{PP}$  =3.0V or 12V, and  $T_{A}$ =+25°C. Assumes corresponding lock bits are not set. Subject to change based on device characterization.
- 2. Excludes external system-level overhead.
- 3. Sampled, but not 100% tested.
- 4. A latency time is required from writing suspend command (F-WE or F-CE going high) until SR.7 going "1" or F-RY/BY going High-Z.
- 5. If the interval time from a Block Erase Resume command to a subsequent Block Erase Suspend command is shorter than t<sub>ERES</sub> and its sequence is repeated, the block erase operation may not be finished.

# 12.5 Flash Memory AC Characteristics Timing Chart

AC Waveform for Single Asynchronous Read Operations from Status Register, Identifier Codes or Query Code





# AC Waveform for Write Operations(F- $\overline{WE}$ / F- $\overline{CE}$ Controlled) NOTE 2 NOTE 3 NOTE 4 NOTE 5 $A_{21-0} (A) \frac{V_{IH}}{V_{IL}}$ VALID ADDRESS VALID ADDRESS $t_{\rm AVAV}$ $t_{\rm AVWH} \left( t_{\rm AVEH} \right)$ $t_{WHAX}$ $(t_{\mathrm{EHAX}})$ NOTES 5, 6 $t_{\rm WHEH}\,(t_{\rm EHWH})$ $t_{\text{WHGL}}\left(t_{\text{EHGL}}\right)$ NOTES 5, 6 $F-\overline{OE}(G)$ $V_{IL}$ $t_{PHWL}\left(t_{PHEL}\right)$ $t_{\mathrm{WHWL}}(t_{\mathrm{EHEL}})$ $F-\overline{WE}(W) V_{IL}^{V_{IH}}$ $t_{WHQV1,2,3} (t_{EHQV1,2,3})$ $t_{WLWH}$ $(t_{\text{ELEH}})$ $t_{DVWH}(t_{DVEH})$ $t_{\mathrm{WHDX}}\left(t_{\mathrm{EHDX}}\right)$ $DQ_{15\text{-}0}(D/Q) \frac{V_{IH}}{V_{IL}}$ DATA IN DATA IN $t_{\rm WHR0} \, (t_{\rm EHR0})$ High-Z $t_{\mathrm{WHRL}}\left(t_{\mathrm{EHRL}}\right)$ $F-RY/\overline{BY}(R)$ ("1") (SR.7) $\overline{\text{F-RST}} \text{ (P)} \frac{\text{V}_{\text{IH}}}{\text{V}_{\text{IL}}}$ $t_{SHWH}\left(t_{SHEH}\right)$ $t_{QVSL}$ $F-\overline{WP}(S) \begin{array}{c} V_{IH} \\ V_{IL} \end{array}$ $t_{\rm VVWH} (t_{\rm VVEH})$ $t_{QVVL}$ $F\text{-}V_{PP}(V) \ V_{PPLK}$ Notes: 1. F-VCC power-up and standby. 2. Write each first cycle command. 3. Write each second cycle command or valid address and data. 4. Automated erase or program delay. 5. Read status register data. 6. For read operation, F-OE and F-CE must be driven active, and F-WE de-asserted.

#### 12.6 Reset Operations

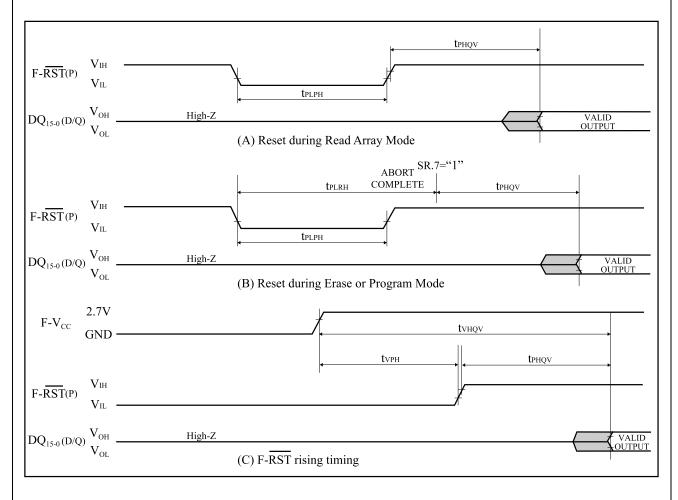
$(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, F-V_{CC} = 2.7V \text{ to}$	3.3V)	į
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Symbol	Parameter	Notes	Min.	Max.	Unit
$t_{\rm PLPH}$	F-\overline{RST} Low to Reset during Read (F-\overline{RST} should be low during power-up.)		100		ns
t <sub>PLRH</sub>	RH F-RST Low to Reset during Erase or Program			22	μs
t <sub>VPH</sub>	t <sub>VPH</sub> F-V <sub>CC</sub> 2.7V to F-RST High		100		ns
t <sub>VHQV</sub>	F-V <sub>CC</sub> 2.7V to Output Delay			1	ms

#### Notes:

- 1. A reset time, t<sub>PHQV</sub>, is required from the later of SR.7 (F-RY/BY) going "1" (High-Z) or F-RST going high until outputs are valid. See the AC Characteristics read cycle for t<sub>PHQV</sub>.
- 2.  $t_{PLPH}$  is <100ns the device may still reset but this is not guaranteed.
- 3. Sampled, not 100% tested.
- 4. If F-RST asserted while a block erase, full chip erase or (page buffer) program operation is not executing, the reset will complete within 100ns.
- 5. When the device power-up, holding  $F-\overline{RST}$  low minimum 100ns is required after  $F-V_{CC}$  has been in predefined range and also has been in stable there.

# AC Waveform for Reset Operation



# 13. AC Electrical Characteristics for SRAM

# 13.1 AC Test Conditions

Input pulse level	0.4 V to 2.2 V
Input rise and fall time	5 ns
Input and Output timing Ref. level	1.5 V
Output load	$1TTL + C_L (30pF)^{(1)}$

## Note:

1. Including scope and socket capacitance.

# 13.2 Read Cycle

 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, \text{ S-V}_{CC} = 2.7 \text{V to } 3.3 \text{V})$ 

Symbol	Parameter	Notes	Min.	Max.	Unit
t <sub>RC</sub>	Read Cycle Time		70		ns
t <sub>AA</sub>	Address Access Time			70	ns
t <sub>ACE1</sub>	Chip Enable Access Time (S- $\overline{\text{CE}}_1$ )			70	ns
t <sub>ACE2</sub>	Chip Enable Access Time (S-CE <sub>2</sub> )			70	ns
$t_{ m BE}$	Byte Enable Access Time			70	ns
t <sub>OE</sub>	Output Enable to Output Valid			35	ns
t <sub>OH</sub>	Output Hold from Address Change		10		ns
$t_{LZ1}$	S-\overline{CE}_1 Low to Output Active	1	10		ns
$t_{LZ2}$	S-CE <sub>2</sub> High to Output Active	1	10		ns
t <sub>OLZ</sub>	S-OE Low to Output Active	1	5		ns
$t_{ m BLZ}$	S-UB or S-LB Low to Output Active	1	10		ns
t <sub>HZ1</sub>	S-\overline{CE}_1 High to Output in High-Z	1	0	25	ns
t <sub>HZ2</sub>	S-CE <sub>2</sub> Low to Output in High-Z	1	0	25	ns
t <sub>OHZ</sub>	S-OE High to Output in High-Z	1	0	25	ns
t <sub>BHZ</sub>	S-UB or S-LB High to Output in High-Z	1	0	25	ns

## Note:

1. Active output to High-Z and High-Z to output active tests specified for a  $\pm 200 \text{mV}$  transition from steady state levels into the test load.

# 13.3 Write Cycle

 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C, \text{ S-V}_{CC} = 2.7\text{V to } 3.3\text{V})$ 

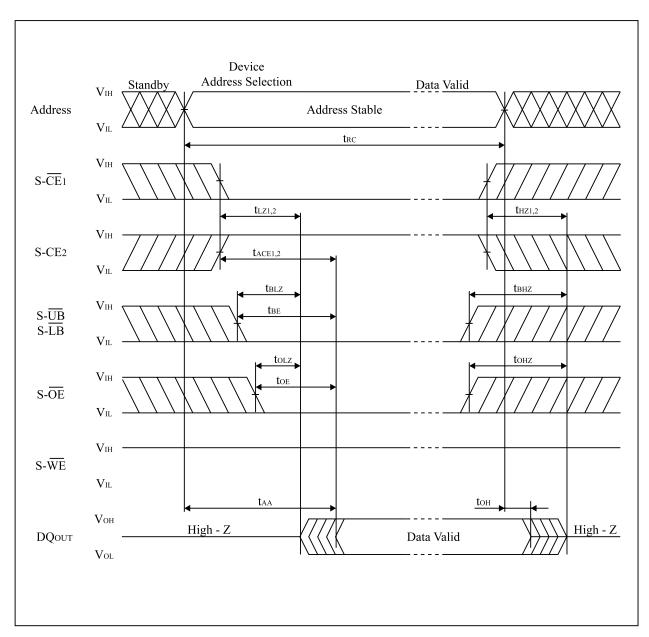
Symbol	Parameter	Notes	Min.	Max.	Unit
t <sub>WC</sub>	Write Cycle Time		70		ns
$t_{CW}$	Chip Enable to End of Write		60		ns
t <sub>AW</sub>	Address Valid to End of Write		60		ns
$t_{BW}$	Byte Select Time		60		ns
$t_{AS}$	Address Setup Time		0		ns
$t_{WP}$	Write Pulse Width		50		ns
$t_{WR}$	Write Recovery Time		0		ns
$t_{DW}$	Input Data Setup Time		30		ns
t <sub>DH</sub>	Input Data Hold Time		0		ns
t <sub>OW</sub>	S-WE High to Output Active	1	5		ns
$t_{WZ}$	S-WE Low to Output in High-Z	1	0	20	ns

# Note:

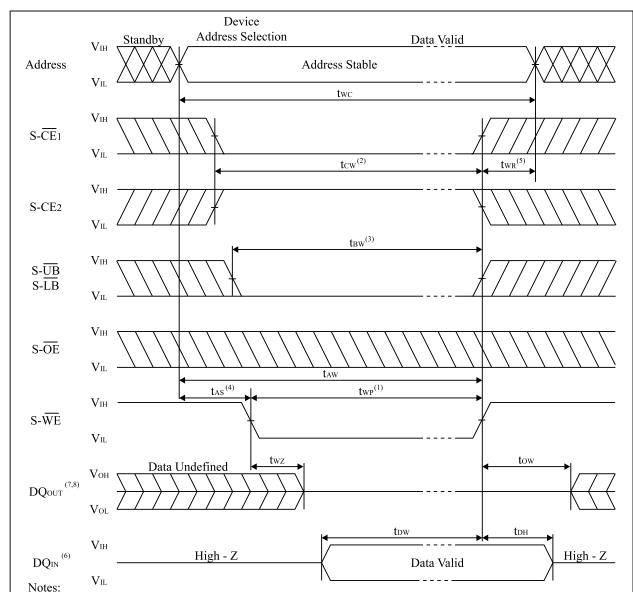
1. Active output to High-Z and High-Z to output active tests specified for a  $\pm 200 \text{mV}$  transition from steady state levels into the test load.

# 13.4 SRAM AC Characteristics Timing Chart

# Read Cycle Timing Chart



# Write Cycle Timing Chart (S-WE Controlled)



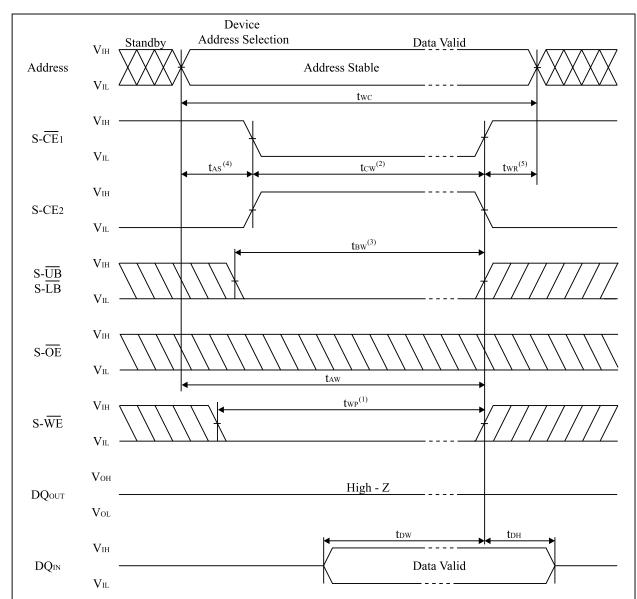
- 1. A write occurs during the overlap of a low S- $\overline{CE}_1$ , a high S-CE2 and a low S- $\overline{WE}$ .

  A write begins at the latest transition among S- $\overline{CE}_1$  going low, S-CE2 going high and S- $\overline{WE}$  going low.

  A write ends at the earliest transition among S- $\overline{CE}_1$  going high, S-CE2 going low and S- $\overline{WE}$  going high.

  twp is measured from the beginning of write to the end of write.
- 2. tcw is measured from the later of S- $\overline{\text{CE}}_1$  going low or S-CE2 going high to the end of write.
- 3. t<sub>BW</sub> is measured from the time of going low  $S-\overline{UB}$  or low  $S-\overline{LB}$  to the end of write.
- 4. tas is measured from the address valid to beginning of write.
- 5. twr is measured from the end of write to the address change. twr applies in case a write ends at S-\overline{CE}\_1 going high, S-CE\_2 going low or S-\overline{WE} going high.
- 6. During this period DQ pins are in the output state, therefore the input signals of opposite phase to the outputs must not be applied.
- 7. If S- $\overline{\text{CE}}_1$  goes low or S-CE<sub>2</sub> goes high simultaneously with S- $\overline{\text{WE}}$  going low or after S- $\overline{\text{WE}}$  going low, the outputs remain in high impedance state.
- 8. If S-\overline{CE}\_1 goes high or S-CE\_2 goes low simultaneously with S-\overline{WE} going high or before S-\overline{WE} going high, the outputs remain in high impedance state.

# Write Cycle Timing Chart (S-\overline{CE} Controlled)

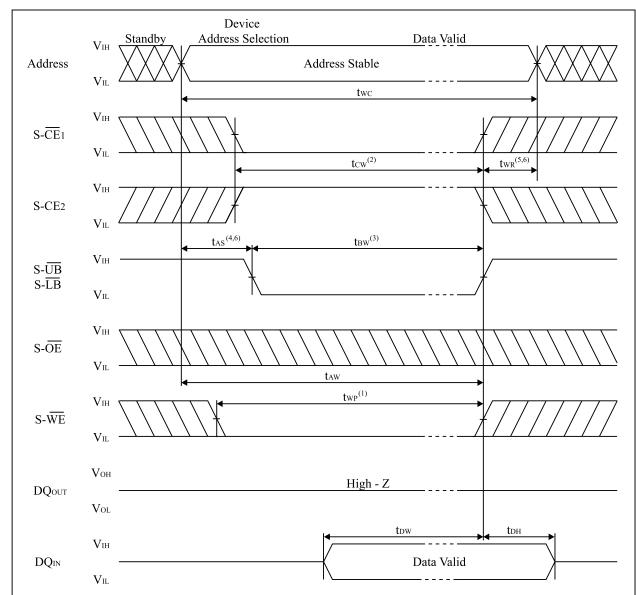


- 1. A write occurs during the overlap of a low S- $\overline{CE}_1$ , a high S-CE<sub>2</sub> and a low S- $\overline{WE}$ .

  A write begins at the latest transition among S- $\overline{CE}_1$  going low, S-CE<sub>2</sub> going high and S- $\overline{WE}$  going low.

  A write ends at the earliest transition among S- $\overline{CE}_1$  going high, S-CE<sub>2</sub> going low and S- $\overline{WE}$  going high. two is measured from the beginning of write to the end of write.
- 2. tcw is measured from the later of  $S-\overline{CE}_1$  going low or  $S-CE_2$  going high to the end of write.
- 3. t<sub>BW</sub> is measured from the time of going low  $S-\overline{UB}$  or low  $S-\overline{LB}$  to the end of write.
- 4. tas is measured from the address valid to beginning of write.
- 5. twr is measured from the end of write to the address change. twr applies in case a write ends at S-\overline{CE}\_1 going high, S-CE\_2 going low or S-\overline{WE} going high.

# Write Cycle Timing Chart (S-UB, S-LB Controlled)



- 1. A write occurs during the overlap of a low S-\overline{CE}\_1, a high S-CE2 and a low S-\overline{WE}.

  A write begins at the latest transition among S-\overline{CE}\_1 going low, S-CE2 going high and S-\overline{WE} going low.

  A write ends at the earliest transition among S-\overline{CE}\_1 going high, S-CE2 going low and S-\overline{WE} going high.

  twp is measured from the beginning of write to the end of write.
- 2. tcw is measured from the later of  $S-\overline{CE}_1$  going low or  $S-CE_2$  going high to the end of write.
- 3. the is measured from the time of going low  $S-\overline{UB}$  or low  $S-\overline{LB}$  to the end of write.
- 4. tas is measured from the address valid to beginning of write.
- 5. twr is measured from the end of write to the address change. twr applies in case a write ends at S-\overline{CE}\_1 going high, S-CE\_2 going low or S-\overline{WE} going high.
- 6. S-UB and S-LB need to make the time of start of a cycle, and an end "high" level for reservation of tas and twr.

#### 14. Data Retention Characteristics for SRAM

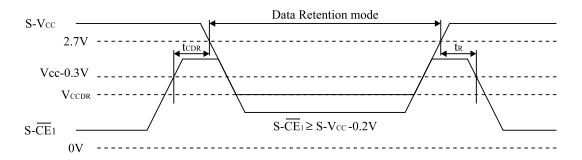
 $(T_A = -25^{\circ}C \text{ to } +85^{\circ}C)$ 

Symbol	Parameter	Note	Min.	Typ. <sup>(1)</sup>	Max.	Unit	Conditions
V <sub>CCDR</sub>	Data Retention Supply voltage	2	1.5		3.3	V	$S-CE_2 \le 0.2V$ or $S-\overline{CE}_1 \ge S-V_{CC} - 0.2V$
I <sub>CCDR</sub>	Data Retention Supply current	2			8	μΑ	$\begin{aligned} & \text{S-V}_{\text{CC}} = 1.5\text{V}, \\ & \text{S-CE}_2 \le 0.2\text{V or} \\ & \text{S-}\overline{\text{CE}}_1 \ge \text{S-V}_{\text{CC}} - 0.2\text{V} \end{aligned}$
t <sub>CDR</sub>	Chip enable setup time		0			ns	
t <sub>R</sub>	Chip enable hold time		t <sub>RC</sub>			ns	

#### Notes

- 1. Reference value at  $T_A = 25$ °C, S- $V_{CC} = 3.0$ V.
- 2.  $S-\overline{CE}_1 \ge S-V_{CC} 0.2V$ ,  $S-CE_2 \ge S-V_{CC} 0.2V$  ( $S-\overline{CE}_1$  controlled) or  $S-CE_2 \le 0.2V$  ( $S-CE_2$  controlled).

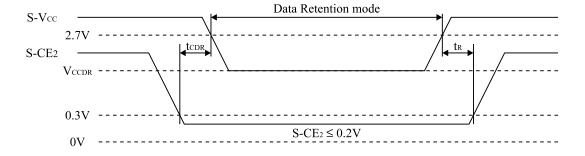
# Data Retention timing chart (S-\overline{CE}\_1 Controlled)^{(1)}



#### Note:

1. To control the data retention mode at  $S-\overline{CE}_1$ , fix the input level of  $S-CE_2$  between "Vccdr and Vccdr-0.2V" or "0V and 0.2V" during the data retention mode.

# Data Retention timing chart (S-CE2 Controlled)



#### 15. Notes

This product is a stacked CSP package that a 64M (x16) bit Flash Memory, a 64M (x16) bit Flash Memory and a 16M (x16) bit SRAM are assembled into.

#### - Supply Power

Maximum difference (between F-V<sub>CC</sub> and S-V<sub>CC</sub>) of the voltage is less than 0.3V.

## - Power Supply and Chip Enable of Flash Memory and SRAM

Two or more chips among Flash memory (F<sub>1</sub>, F<sub>2</sub>) and SRAM should not be active simultaneously.

If the two memories are active together, possibly they may not operate normally by interference noises or data collision on DO bus.

Both  $F-V_{CC}$  and  $S-V_{CC}$  are needed to be applied by the recommended supply voltage at the same time expect SRAM data retention mode.

#### - Power Up Sequence

When turning on Flash memory power supply, keep F- $\overline{RST}$  low. After F-V<sub>CC</sub> reaches over 2.7V, keep F- $\overline{RST}$  low for more than 100 nsec.

#### - Device Decoupling

The power supply is needed to be designed carefully because the Flash Memory (or the SRAM) is in standby mode when the SRAM (or the Flash Memory) is active. A careful decoupling of power supplies is necessary between SRAM and Flash Memory. Note peak current caused by transition of control signals ( $F_{1,2}$ - $\overline{CE}$ , S- $\overline{CE}_1$ , S- $\overline{CE}_2$ ).



#### 16. Flash Memory Data Protection

Noises having a level exceeding the limit specified in the specification may be generated under specific operating conditions on some systems. Such noises, when induced onto F-WE signal or power supply, may be interpreted as false commands and causes undesired memory updating. To protect the data stored in the flash memory against unwanted writing, systems operating with the flash memory should have the following write protect designs, as appropriate:

- The below describes data protection method.
  - 1. Protection of data in each block
    - Any locked block by setting its block lock bit is protected against the data alternation. When F-WP is low, any locked-down block by setting its block lock-down bit is protected from lock status changes.
       By using this function, areas can be defined, for example, program area (locked blocks), and data area (unlocked blocks).
    - For detailed block locking scheme, see Chapter 5.Command Definitions for Flash Memory.
  - 2. Protection of data with F-V<sub>PP</sub> control
    - When the level of F-V<sub>PP</sub> is lower than V<sub>PPLK</sub> (F-V<sub>PP</sub> lockout voltage), write functions to all blocks are disabled. All blocks are locked and the data in the blocks are completely protected.
  - 3. Protection of data with F-RST
    - Especially during power transitions such as power-up and power-down, the flash memory enters reset mode by bringing F-RST to low, which inhibits write operation to all blocks.
    - For detailed description on F-RST control, see Chapter 12.6 AC Electrical Characteristics for Flash Memory, Reset Operations.
- Protection against noises on F-WE signal

To prevent the recognition of false commands as write commands, system designer should consider the method for reducing noises on  $F-\overline{WE}$  signal.

## 17. Design Considerations

# 1. Power Supply Decoupling

To avoid a bad effect to the system by flash memory power switching characteristics, each device should have a  $0.1\mu F$  ceramic capacitor connected between its F-V<sub>CC</sub> and GND and between its F-V<sub>PP</sub> and GND.

Low inductance capacitors should be placed as close as possible to package leads.

# 2. $F-V_{PP}$ Trace on Printed Circuit Boards

Updating the memory contents of flash memories that reside in the target system requires that the printed circuit board designer pay attention to the F-V<sub>PP</sub> Power Supply trace. Use similar trace widths and layout considerations given to the F-V<sub>CC</sub> power bus.

#### 3. The Inhibition of Overwrite Operation

Please do not execute reprograming "0" for the bit which has already been programed "0". Overwrite operation may generate unerasable bit.

In case of reprograming "0" to the data which has been programed "1".

- Program "0" for the bit in which you want to change data from "1" to "0".
- Program "1" for the bit which has already been programed "0".

For example, changing data from "1011110110111101" to "1010110110111100" requires "11101111111111110" programing.

#### 4. Power Supply

Block erase, full chip erase, (page buffer) program with an invalid F-V<sub>PP</sub> (See Chapter 11. DC Electrical Characteristics) produce spurious results and should not be attempted.

Device operations at invalid  $F-V_{CC}$  voltage (See Chapter 11. DC Electrical Characteristics) produce spurious results and should not be attempted.

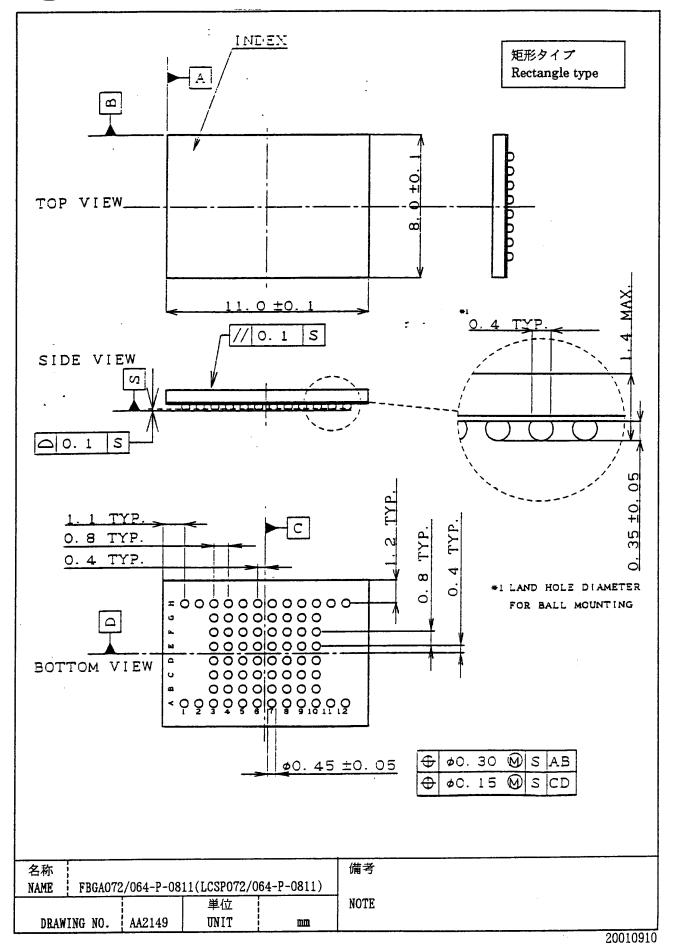
## 18. Related Document Information<sup>(1)</sup>

Document No.	Document Name
FUM00701 LH28F320BF, LH28F640BF Series Appendix	

## Note:

1. International customers should contact their local SHARP or distribution sales offices.

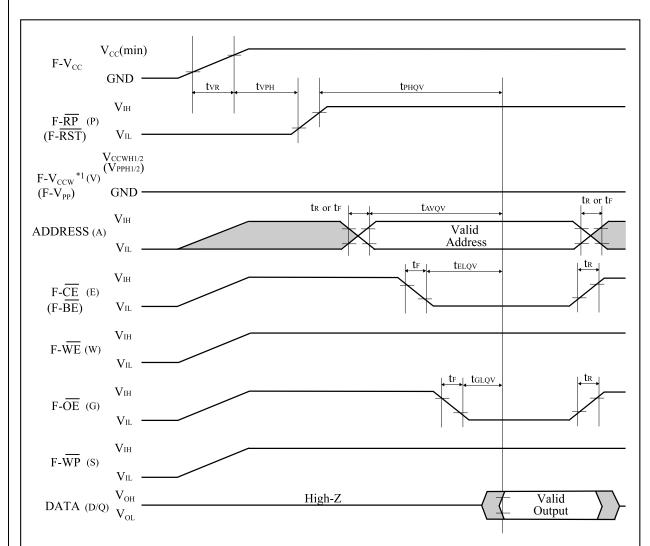
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## A-1 RECOMMENDED OPERATING CONDITIONS

# A-1.1 At Device Power-Up

AC timing illustrated in Figure A-1 is recommended for the supply voltages and the control signals at device power-up. If the timing in the figure is ignored, the device may not operate correctly.



\*1 To prevent the unwanted writes, system designers should consider the design, which applies F-V<sub>CCW</sub> (F-V<sub>PP</sub>) to 0V during read operations and V<sub>CCWH1/2</sub> (V<sub>PPH1/2</sub>) during write or erase operations. See the application note AP-007-SW-E for details.

Figure A-1. AC Timing at Device Power-Up

For the AC specifications  $t_{VR}$ ,  $t_R$ ,  $t_F$  in the figure, refer to the next page. See the "AC Electrical Characteristics for Flash Memory" described in specifications for the supply voltage range, the operating temperature and the AC specifications not shown in the next page.



# A-1.1.1 Rise and Fall Time

Symbol	Parameter	Notes	Min.	Max.	Unit
$t_{VR}$	F-V <sub>CC</sub> Rise Time		0.5	30000	μs/V
t <sub>R</sub>	Input Signal Rise Time			1	μs/V
t <sub>F</sub>	Input Signal Fall Time	1, 2		1	μs/V

# NOTES:

- 1. Sampled, not 100% tested.
- 2. This specification is applied for not only the device power-up but also the normal operations.

# A-1.2 Glitch Noises

Do not input the glitch noises which are below  $V_{IH}$  (Min.) or above  $V_{IL}$  (Max.) on address, data, reset, and control signals, as shown in Figure A-2 (b). The acceptable glitch noises are illustrated in Figure A-2 (a).

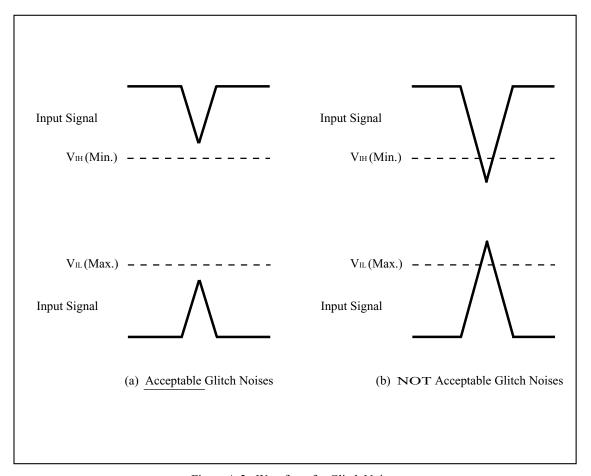


Figure A-2. Waveform for Glitch Noises

See the "DC Electrical Characteristics" described in specifications for  $V_{IH}$  (Min.) and  $V_{IL}$  (Max.).



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# A-2 RELATED DOCUMENT INFORMATION<sup>(1)</sup>

Document No.	Document Name
AP-001-SD-E	Flash Memory Family Software Drivers
AP-006-PT-E	Data Protection Method of SHARP Flash Memory
AP-007-SW-E	RP#, V <sub>PP</sub> Electric Potential Switching Circuit

# NOTE:

1. International customers should contact their local SHARP or distribution sales office.

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